

LV8729V



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Bi-CMOS LSI

PWM Constant-Current Control Stepper Motor Driver Application Note

Overview

The LV8729V is a PWM current-controlled micro step bipolar stepper motor driver.

This driver can do eight ways of micro step resolution of 1/128 step from Full step, and can drive simply by the CLK input.

Function

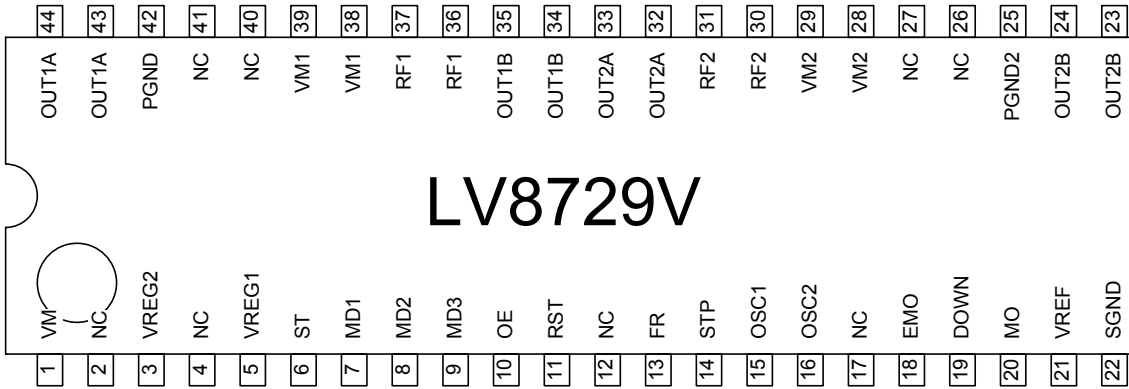
- Low voltage operation (2.5V min)
- Low saturation voltage (upper transistor + lower transistor residual voltage; 0.40V typ at 400mA)
- Parallel connection (Upper transistor + lower transistor residual voltage; 0.5V typ at 800mA)
- Separate logic power supply and motor power supply
- Brake function
- Spark killer diodes built in
- Thermal shutdown circuit built in
- Compact package (14-pin MFP)

Typical Applications

- Security camera
- Projector
- Stage Lighting
- Industrial Printer
- Compact package (14-pin MFP)

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Pin Assignment

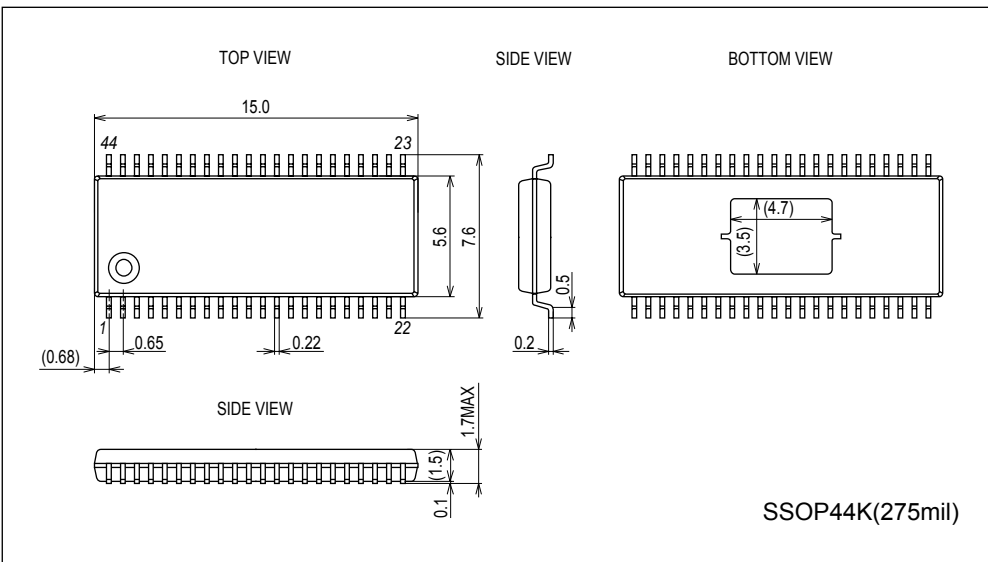


Top view

Package Dimensions

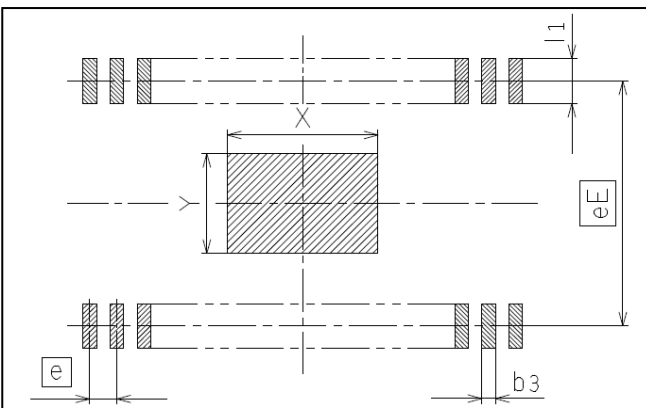
unit : mm (typ)

3333



Caution: The package dimension is a reference value, which is not a guaranteed value.

Recommended Soldering Footprint

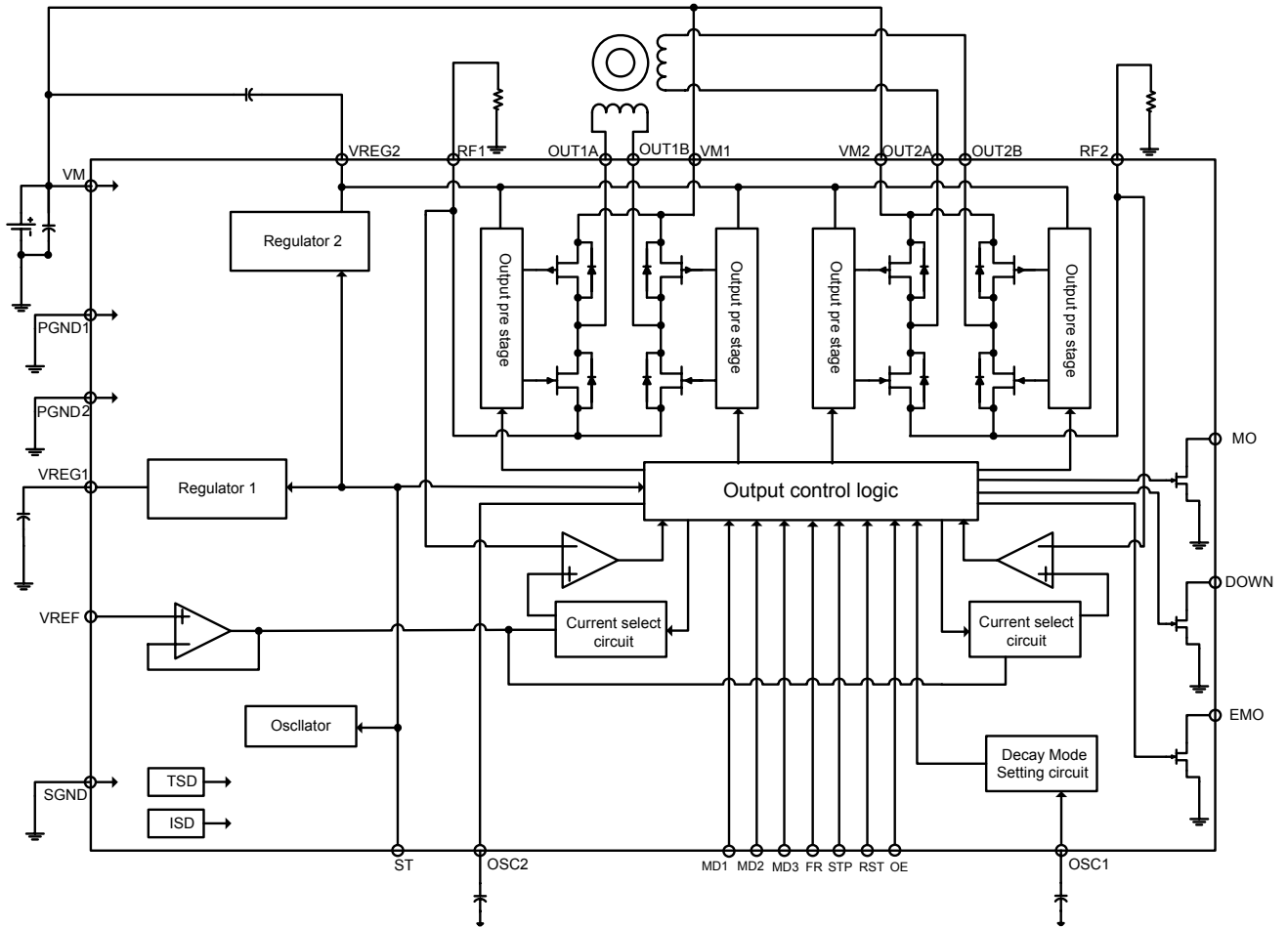


Reference symbol	SSOP44K(275mil)
eE	7.00
e	0.65
b3	0.32
l1	1.00
X	(4.7)
Y	(3.5)

(Unit:mm)

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Block Diagram



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Specifications

Absolute Maximum Ratings at Ta = 25°C

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	VM max		36	V
Maximum output current	IO max		1.8	A
Maximum logic input voltage	VIN max		6	V
Maximum VREF input voltage	VREF max		6	V
Maximum MO input voltage	VMO max		6	V
Maximum DOWN input voltage	VDOWN max		6	V
Allowable power dissipation	Pd max	*	3.85	W
Operating temperature	Topr		-30 to +85	°C
Storage temperature	Tstg		-55 to +150	°C

* Specified circuit board: 90.0mm×90.0mm×1.6mm, glass epoxy 2-layer board, with backside mounting

Caution 1) Absolute maximum ratings represent the value which cannot be exceeded for any length of time.

Caution 2) Even when the device is used within the range of absolute maximum ratings, as a result of continuous usage under high temperature, high current, high voltage, or drastic temperature change, the reliability of the IC may be degraded. Please contact us for the further details.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

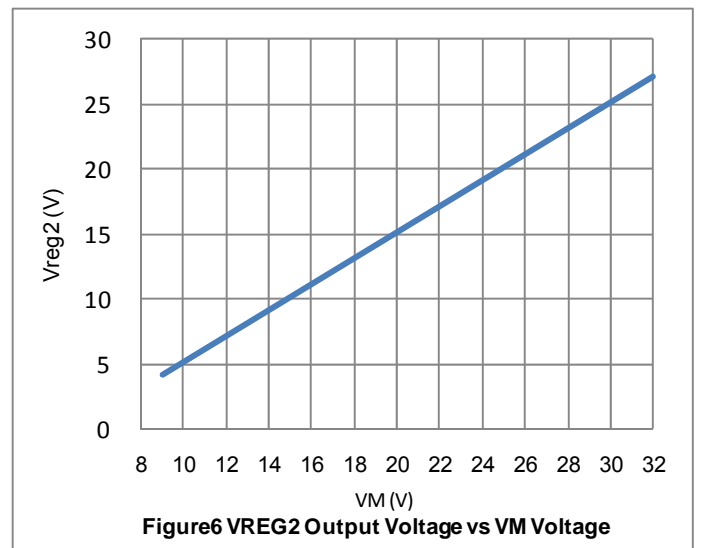
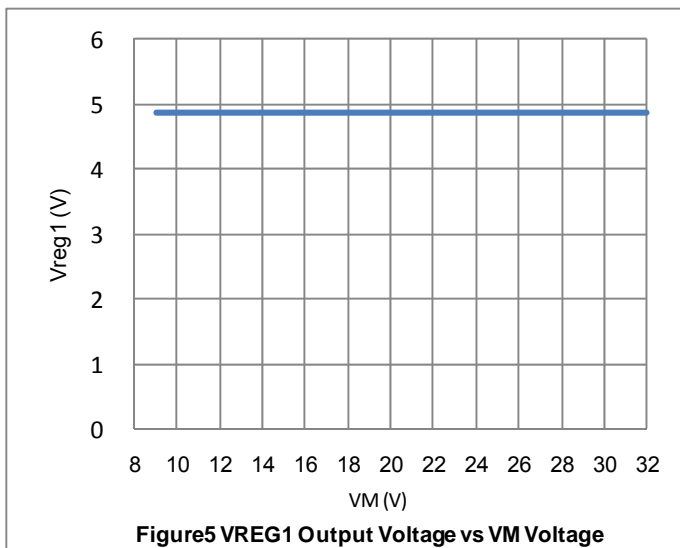
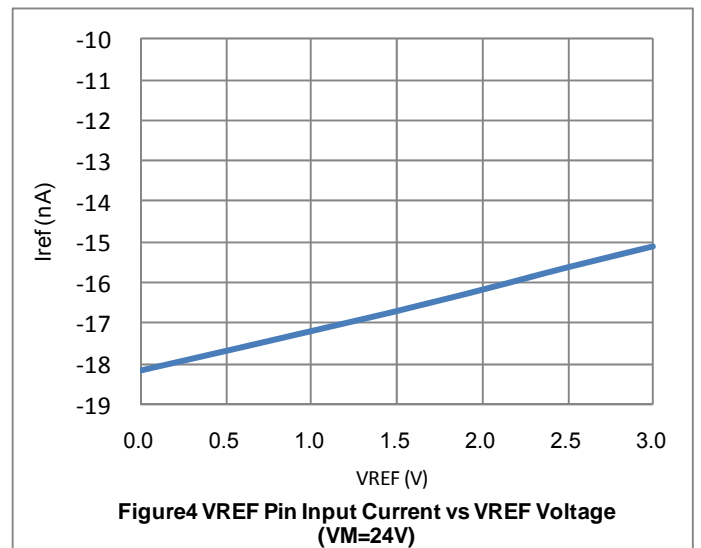
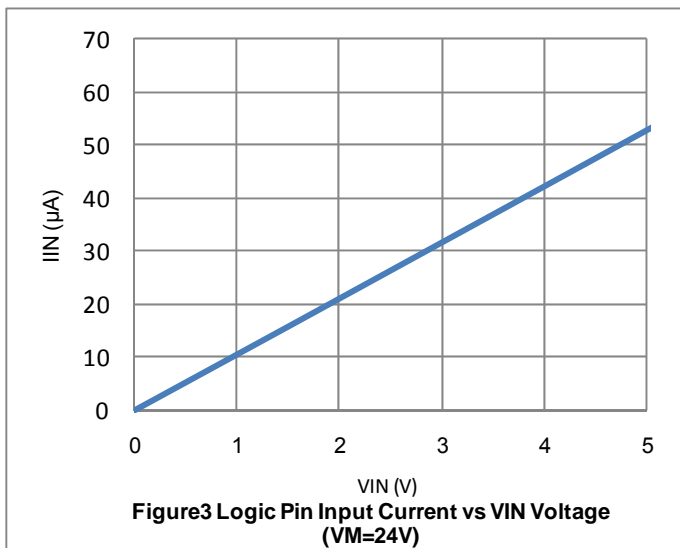
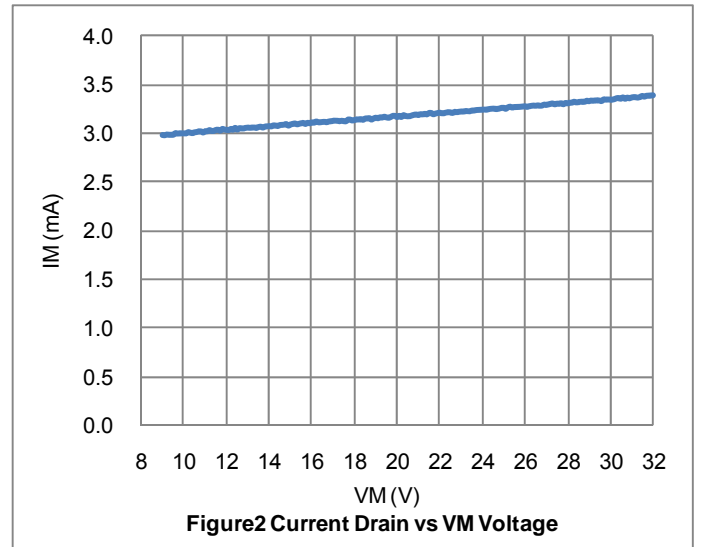
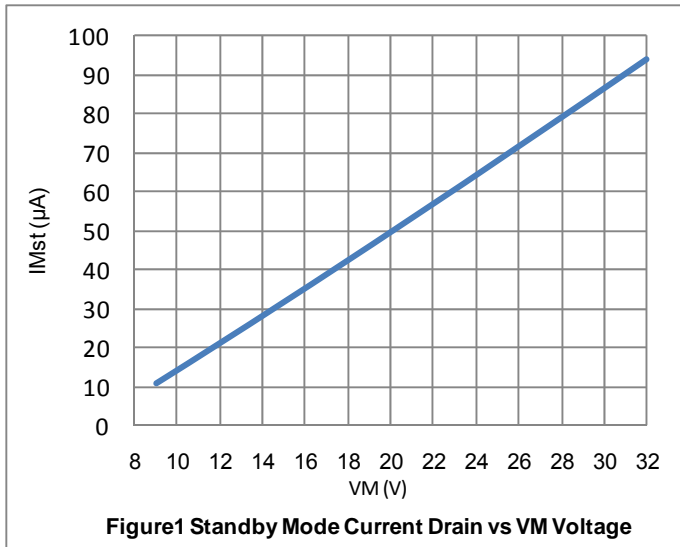
Recommended Operating Conditions at Ta = 25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Supply voltage range	VM		9		32	V
Logic input voltage	VIN		0		5	V
VREF input voltage range	VREF		0		3	V

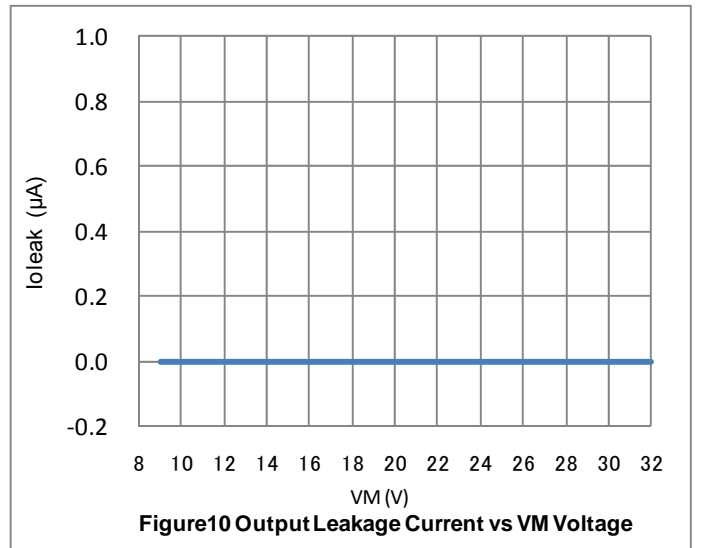
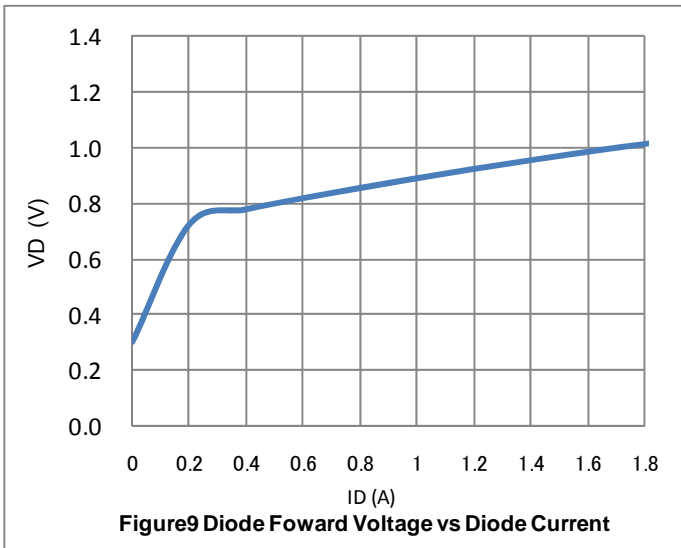
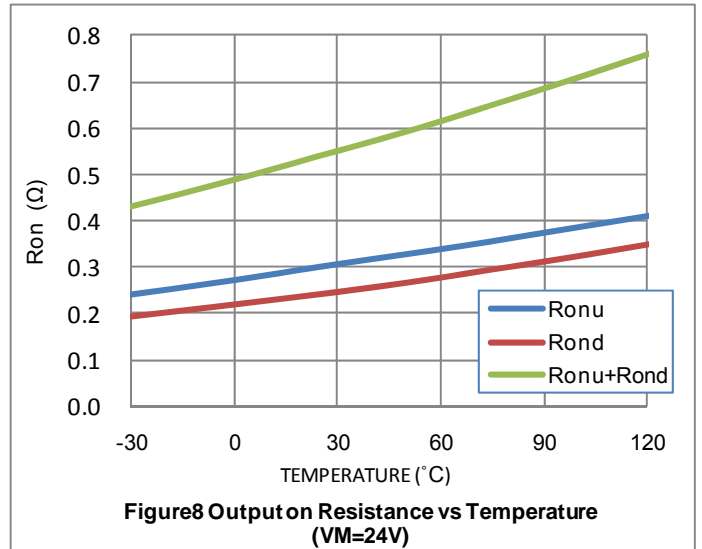
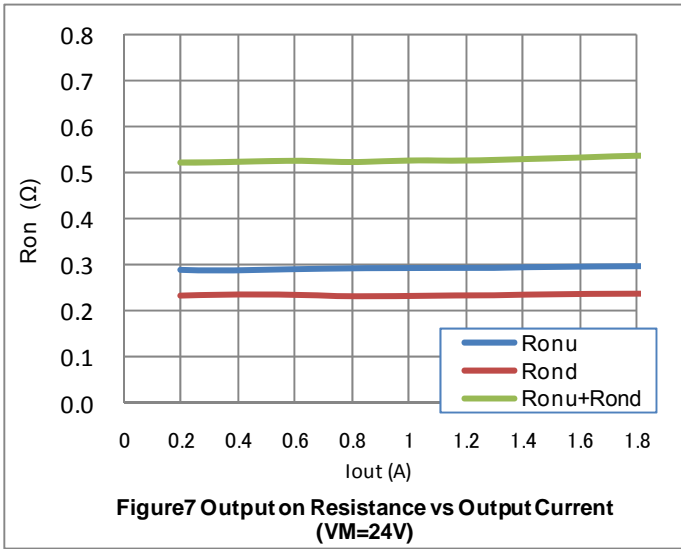
Electrical Characteristics at Ta = 25°C, VM = 24V, VREF = 1.5V

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
Standby mode current drain	IMst	ST = "L"		70	100	μA
Current drain	IM	ST = "H", OE = "H", no load		3.3	4.6	mA
Thermal shutdown temperature	TSD	Design guarantee	150	180	200	°C
Thermal hysteresis width	ΔTSD	Design guarantee		40		°C
Logic pin input current	IINL	VIN = 0.8V	3	8	15	μA
	IINH	VIN = 5V	30	50	70	μA
Logic high-level input voltage	VINH		2.0			V
Logic low-level input voltage	VINL				0.8	V
Chopping frequency	Fch	Cosc1 = 100pF	70	100	130	kHz
OSC1 pin charge/discharge current	Iosc1		7	10	13	μA
Chopping oscillation circuit threshold voltage	Vtup1		0.8	1	1.2	V
	Vtdown1		0.3	0.5	0.7	V
VREF pin input voltage	Iref	VREF = 1.5V	-0.5			μA
DOWN output residual voltage	VO1DOWN	I _{down} = 1mA		40	100	mV
MO pin residual voltage	VO1MO	I _{mo} = 1mA		40	100	mV
Hold current switching frequency	Fdown	Cosc2 = 1500pF	1.12	1.6	2.08	Hz
Hold current switching frequency threshold voltage	Vtup2		0.8	1	1.2	V
	Vtdown2		0.3	0.5	0.7	V
VREG1 output voltage	Vreg1		4.7	5	5.3	V
VREG2 output voltage	Vreg2	VM=24V	18	19	20	V
Output on-resistance	Ronu	IO = 1.8A, high-side ON resistance		0.35	0.455	Ω
	Rond	IO = 1.8A, low-side ON resistance		0.3	0.39	Ω
Output leakage current	IOleak	VM = 36V			50	μA
Diode forward voltage	VD	ID = -1.8A		1	1.4	V
Current setting reference voltage	VRF	VREF = 1.5V, Current ratio 100%	0.285	0.3	0.315	V

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Pin Functions

Pin No.	Pin Name	Pin Function	Equivalent Circuit
7 8 9 10 11 13 14	MD1 MD2 MD3 OE RST FR STP	Excitation mode switching pin Excitation mode switching pin Excitation mode switching pin Output enable signal input pin Reset signal input pin Forward / Reverse signal input pin Step clock pulse signal input pin	
6	ST	Chip enable pin.	
23, 24 25 28, 29 30, 31 32, 33 34, 35 36, 37 38, 39 42 43, 44	OUT2B PGND2 V _M 2 RF2 OUT2A OUT1B RF1 V _M 1 PGND1 OUT1A	Channel 2 OUTB output pin. Channel 2 Power system ground Channel 2 motor power supply connection pin. Channel 2 current-sense resistor connection pin. Channel 2 OUTA output pin. Channel 1 OUTB output pin. Channel 1 current-sense resistor connection pin. Channel 1 motor power supply pin. Channel 1 Power system ground Channel 1 OUTA output pin.	
21	VREF	Constant-current control reference voltage input pin.	

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Pin No.	Pin Name	Pin Function	Equivalent Circuit
3	VREG2	Internal regulator capacitor connection pin.	
5	VREG1	Internal regulator capacitor connection pin.	
18 19 20	EMO DOWN MO	Over-current detection alarm output pin. Holding current output pin. Position detecting monitor pin.	
15 16	OSC1 OSC2	Copping frequency setting capacitor connection pin. Holding current detection time setting capacitor connection pin.	

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
Reference describing operation

(1) Stand-by function

When ST pin is at low levels, the IC enters stand-by mode, all logic is reset and output is turned OFF.
When ST pin is at high levels, the stand-by mode is released.

(2) STEP pin function

STEP input advances electrical angle at every rising edge (advances step by step).

Input		Operating mode
ST	STP	
Low	*	Standby mode
High		Excitation step proceeds
High		Excitation step is kept

STEP input MIN pulse width (common in H/L): 500ns (MAX input frequency: 1MHz)

However, constant current control is performed by PWM during chopping period, which is set by the capacitor connected between OSC1 and GND. You need to perform chopping more than once per step. For this reason, for the actual STEP frequency, you need to take chopping frequency and chopping count into consideration.

For example, if chopping frequency is 50kHz (20μs) and chopping is performed twice per step, the maximum STEP frequency is obtained as follows: $f = 1/(20\mu s \times 2) = 25kHz$.

(3) Input timing

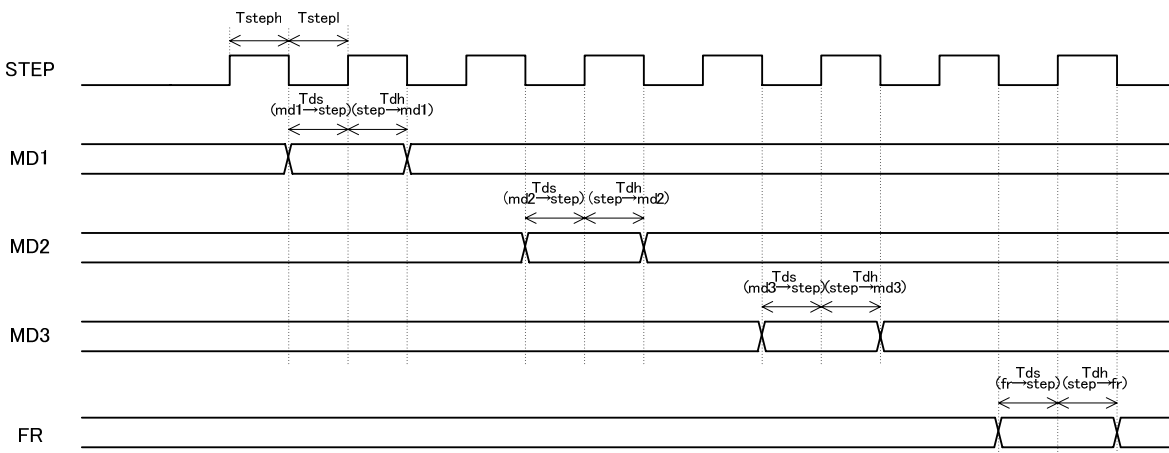


Figure 11. Input timing chart

TstepH/TstepL : Clock H/L pulse width (min 500ns)

Tds : Data set-up time (min 500ns)

Tdh : Data hold time (min 500ns)

(4) Excitation setting method

Set the micro step resolution setting as shown in the following table by setting MD1 pin, MD2 pin and MD3 pin.

Input			Micro step resolution	Excitation mode	Initial position	
MD3	MD2	MD1			1ch current	2ch current
Low	Low	Low	Full Step	2-phase	100%	-100%
Low	Low	High	Half Step	1-2 phase	100%	0%
Low	High	Low	Quarter Step	W1-2 phase	100%	0%
Low	High	High	1/8 Step	2W1-2 phase	100%	0%
High	Low	Low	1/16 Step	4W1-2 phase	100%	0%
High	Low	High	1/32 Step	8W1-2 phase	100%	0%
High	High	Low	1/64 Step	16W1-2 phase	100%	0%
High	High	High	1/128 Step	32W1-2 phase	100%	0%

The initial position is also the default state at start-up and excitation position at counter-reset in each Micro step resolution.

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(5) Position detection monitoring function

The MO position detection monitoring pin is of an open drain type.
 When the excitation position is in the initial position, the MO output is placed in the ON state.
 (Refer to "Examples of current waveforms in each of the excitation modes.")

(6) Output current setting

Output current is set shown below by the VREF pin (applied voltage) and a resistance value between RF1 (2) pin and GND.

$$I_{OUT} = (VREF / 5) / RF1 \text{ (2) resistance}$$

* The setting value above is a 100% output current in each micro step resolution.

(Example) When VREF = 1.1V and RF1 (2) resistance is 0.22Ω, the setting is shown below.

$$I_{OUT} = (1.1V / 5) / 0.22\Omega = 1.0A$$

If VREF is open or the setting is out of the recommendation operating range, output current will increase and you cannot set constant current under normal condition. Hence, make sure that VREF is set in accordance with the specification.

However, if current control is not performed (if the IC is used without saturation drive or current limit) make sure that the setting is as follows: VREF=5V or VREF=VREG1

(7) Output enable function

When the OE pin is set Low, the output is forced OFF and goes to high impedance. However, the internal logic circuits are operating, so the excitation position proceeds when the STP is input. Therefore, when OE pin is returned to High, the output level conforms to the excitation position proceeded by the STP input.

OE	Operating mode
High	Output ON
Low	Output OFF

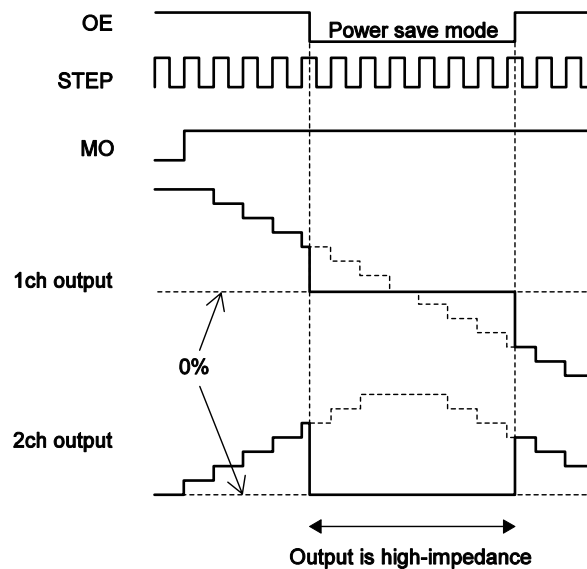


Figure 12. Output enable function timing chart

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(8) Reset function

When the RST pin is set Low, the output goes to initial mode and excitation position is fixed in the initial position for STP pin and FR pin input. MO pin outputs at low levels at the initial position. (Open drain connection)

RST	Operating mode
High	Normal operation
Low	Reset state

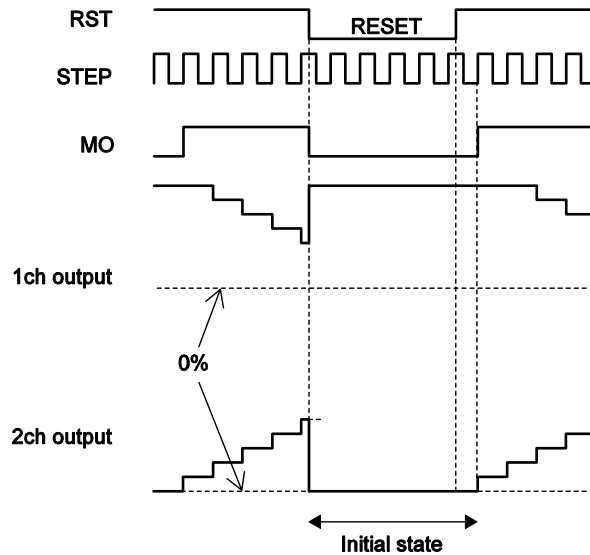


Figure 13. Reset function timing chart

(9) Forward / reverse switching function

FR	Operating mode
Low	Clockwise (CW)
High	Counter-clockwise (CCW)

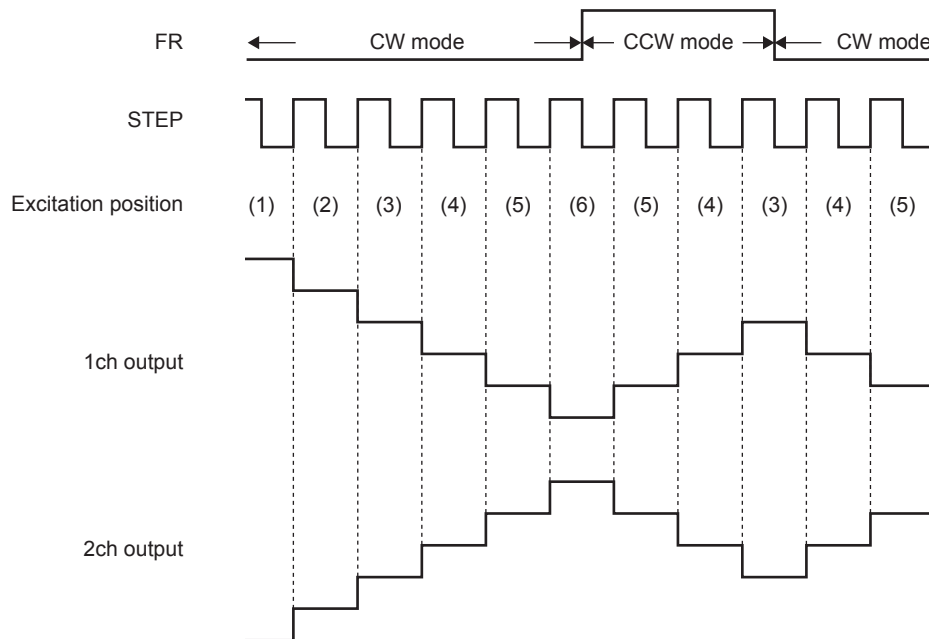


Figure 14. Forward/Reverse switching function timing chart

The internal D/A converter proceeds by a bit on the rising edge of the step signal input to the STP pin. In addition, CW and CCW mode are switched by FR pin setting.

In CW mode, the channel 2 current phase is delayed by 90° relative to the channel 1 current.

In CCW mode, the channel 2 current phase is advanced by 90° relative to the channel 1 current.

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(10)EMO, DOWN output pin

The output pin is open -drain connection. When it becomes prescribed, it turns on, and each pin outputs the Low level.

Pin state	EMO	DOWN
Low	At detection of over-current	Holding current state
OFF	Normal state	Normal state

(11)Chopping frequency setting function

Chopping frequency is set as shown below by a capacitor between OSC1 pin and GND.

$$F_{cp} = 1 / (C_{osc1} / 10 \times 10^{-6}) \text{ (Hz)}$$

(Example) When $C_{osc1} = 180\text{pF}$, the chopping frequency is shown below.

$$F_{cp} = 1 / (180 \times 10^{-12} / 10 \times 10^{-6}) = 55.5\text{(kHz)}$$

The higher the chopping frequency is, the greater the output switching loss becomes. As a result, heat generation issue arises.

The lower the chopping frequency is, the lesser the heat generation becomes. However, current ripple occurs.

Since noise increases when switching of chopping takes place, you need to adjust frequency with the influence to the other devices into consideration. The frequency range should be between 40kHz and 125kHz.

(12)Open-drain pin for switching holding current

The output pin is an open-drain connection.

This pin is turned ON when no rising edge of STP between the input signals while a period determined by a capacitor between OSC2 and GND, and outputs at low levels.

The open-drain output in once turned ON, is turned OFF at the next rising edge of STP.

Holding current switching time (T_{down}) is set as shown below by a capacitor between OSC2 pin and GND.

$$T_{down} = C_{osc2} \times 0.4 \times 10^9 \text{ (s)}$$

(Example) When $C_{osc2} = 1500\text{pF}$, the holding current switching time is shown below.

$$T_{down} = 1500\text{pF} \times 0.4 \times 10^9 = 0.6 \text{ (s)}$$

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(13) Output current vector locus (one step is normalized to 90 degrees)

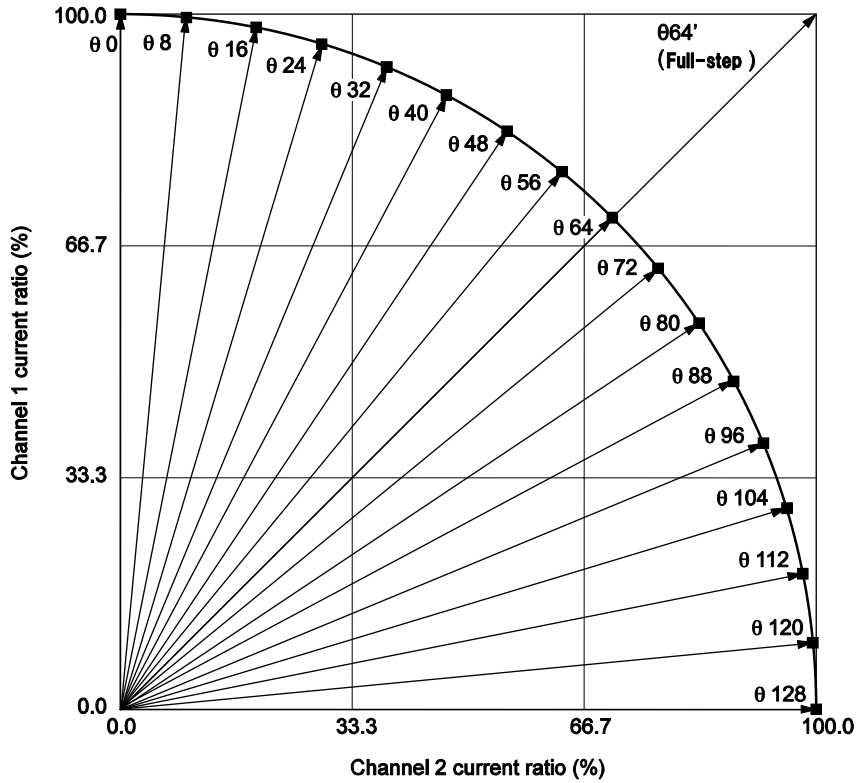


Figure 15. Output current vector

Current setting ratio in each micro step resolution

STEP	1/128 (%)		1/64 (%)		1/32 (%)		1/16 (%)		1/8 (%)		Quarter (%)		Half (%)		Full (%)	
	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch
00	100	0	100	0	100	0	100	0	100	0	100	0	100	0		
01	100	1														
02	100	2	100	2												
03	100	4														
04	100	5	100	5	100	5										
05	100	6														
06	100	7	100	7												
07	100	9														
08	100	10	100	10	100	10	100	10								
09	99	11														
010	99	12	99	12												
011	99	13														
012	99	15	99	15	99	15										
013	99	16														
014	99	17	99	17												
015	98	18														
016	98	20	98	20	98	20	98	20	98	20						
017	98	21														
018	98	22	98	22												
019	97	23														
020	97	24	97	24	97	24										
021	97	25														
022	96	27	96	27												
023	96	28														
024	96	29	96	29	96	29	96	29								
025	95	30														

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STEP	1/128 (%)		1/64 (%)		1/32 (%)		1/16 (%)		1/8 (%)		Quarter (%)		Half (%)		Full (%)	
	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch
026	95	31	95	31												
027	95	33														
028	94	34	94	34	94	34										
029	94	35														
030	93	36	93	36												
031	93	37														
032	92	38	92	38	92	38	92	38	92	38	92	38				
033	92	39														
034	91	41	91	41												
035	91	42														
036	90	43	90	43	90	43										
037	90	44														
038	89	45	89	45												
039	89	46														
040	88	47	88	47	88	47	88	47								
041	88	48														
042	87	49	87	49												
043	86	50														
044	86	51	86	51	86	51										
045	85	52														
046	84	53	84	53												
047	84	55														
048	83	56	83	56	83	56	83	56	83	56						
049	82	57														
050	82	58	82	58												
051	81	59														
052	80	60	80	60	80	60										
053	80	61														
054	79	62	79	62												
055	78	62														
056	77	63	77	63	77	63	77	63								
057	77	64														
058	76	65	76	65												
059	75	66														
060	74	67	74	67	74	67										
061	73	68														
062	72	69	72	69												
063	72	70														
064	71	71	71	71	71	71	71	71	71	71	71	71	71	71	100	100
065	70	72														
066	69	72	69	72												
067	68	73														
068	67	74	67	74	67	74										
069	66	75														
070	65	76	65	76												
071	64	77														
072	63	77	63	77	63	77	63	77								
073	62	78														
074	62	79	62	79												
075	61	80														
076	60	80	60	80	60	80										
077	59	81														
078	58	82	58	82												
079	57	82														
080	56	83	56	83	56	83	56	83	56	83						
081	55	84														
082	53	84	53	84												
083	52	85														
084	51	86	51	86	51	86										
085	50	86														
086	49	87	49	87												
087	48	88														
088	47	88	47	88	47	88	47	88								
089	46	89														
090	45	89	45	89												

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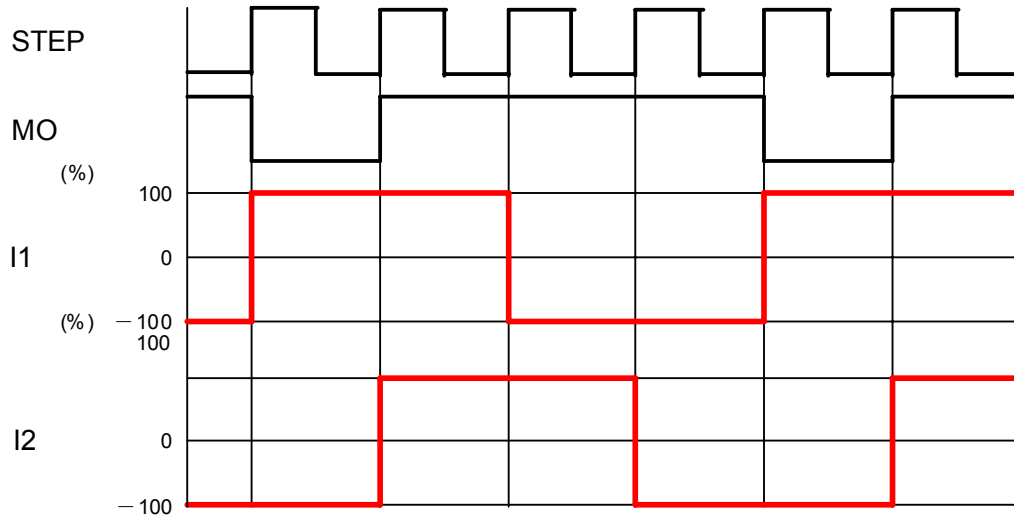
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STEP	1/128 (%)		1/64 (%)		1/32 (%)		1/16 (%)		1/8 (%)		Quarter (%)		Half (%)		Full (%)	
	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch	1ch	2ch
091	44	90														
092	43	90	43	90	43	90										
093	42	91														
094	41	91	41	91												
095	39	92														
096	38	92	38	92	38	92	38	92	38	92	38	92				
097	37	93														
098	36	93	36	93												
099	35	94														
0100	34	94	34	94	34	94										
0101	33	95														
0102	31	95	31	95												
0103	30	95														
0104	29	96	29	96	29	96	29	96								
0105	28	96														
0106	27	96	27	96												
0107	25	97														
0108	24	97	24	97	24	97										
0109	23	97														
0110	22	98	22	98												
0111	21	98														
0112	20	98	20	98	20	98	20	98	20	98						
0113	18	98														
0114	17	99	17	99												
0115	16	99														
0116	15	99	15	99	15	99										
0117	13	99														
0118	12	99	12	99												
0119	11	99														
0120	10	100	10	100	10	100	10	100								
0121	9	100														
0122	7	100	7	100												
0123	6	100														
0124	5	100	5	100	5	100										
0125	4	100														
0126	2	100	2	100												
0127	1	100														
0128	0	100	0	100	0	100	0	100	0	100	0	100	0	100		

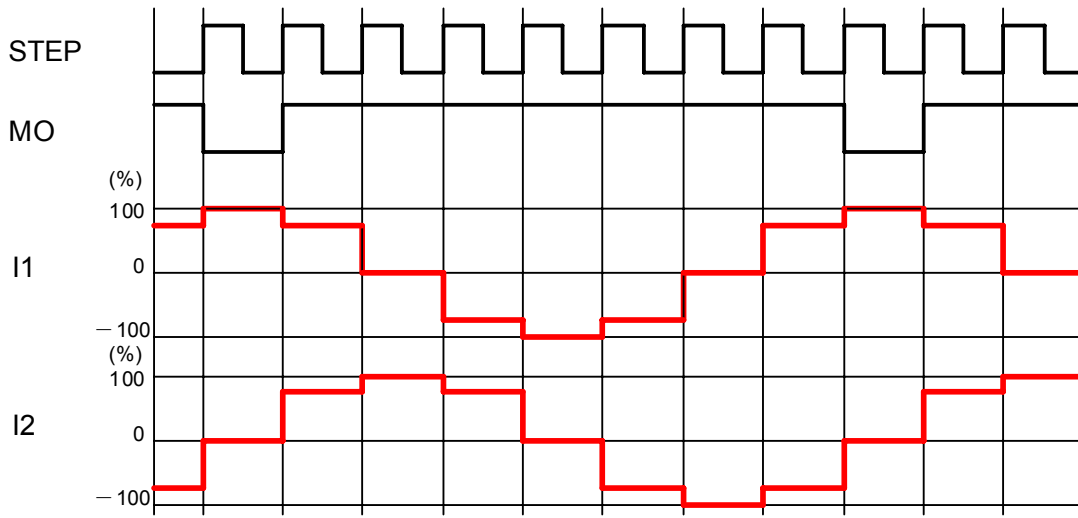
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(14) Current wave example in each micro step resolution.

Full Step (CW)

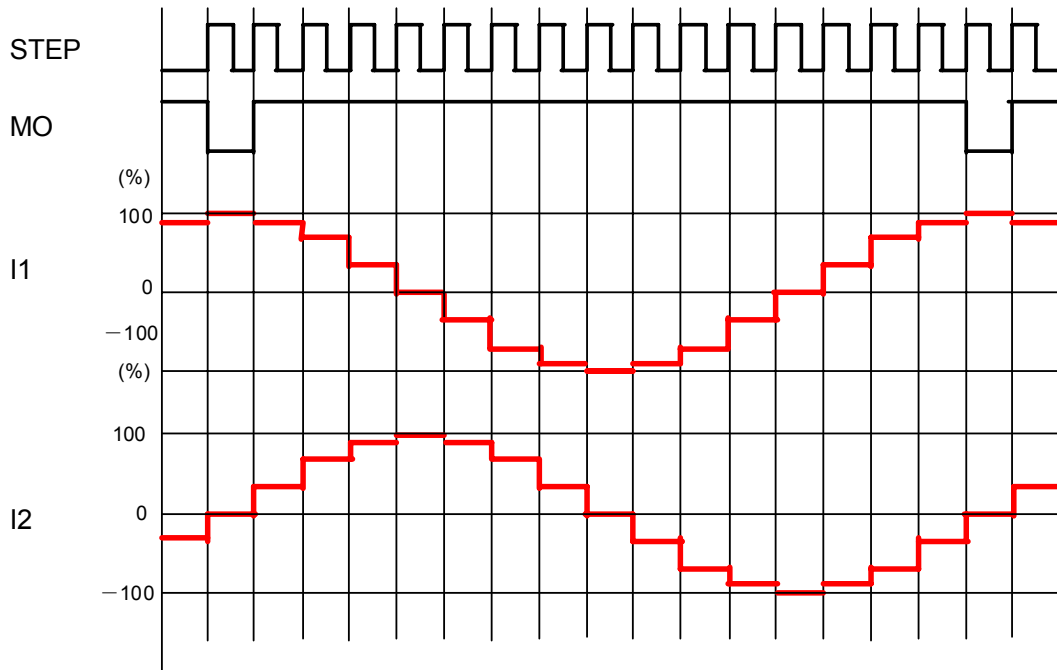


Half Step (CW)

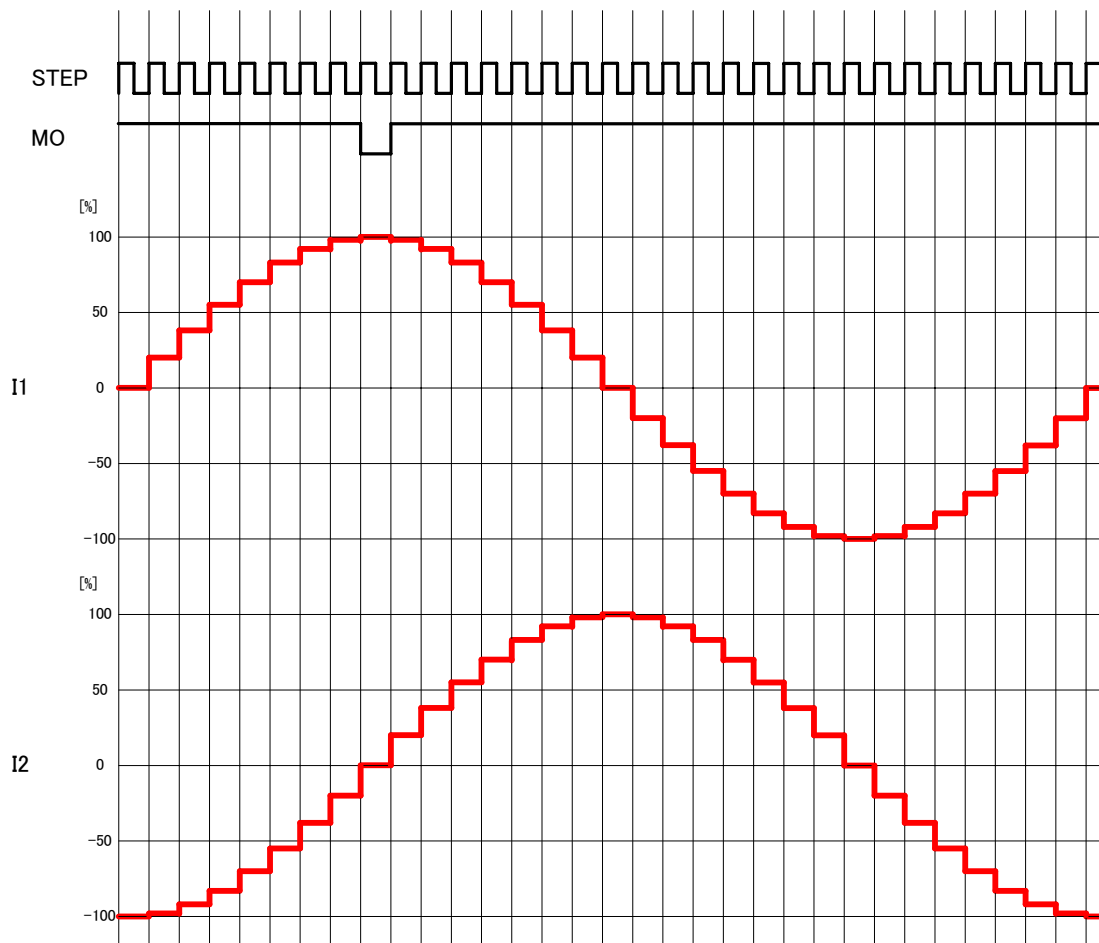


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Quarter Step (CW)

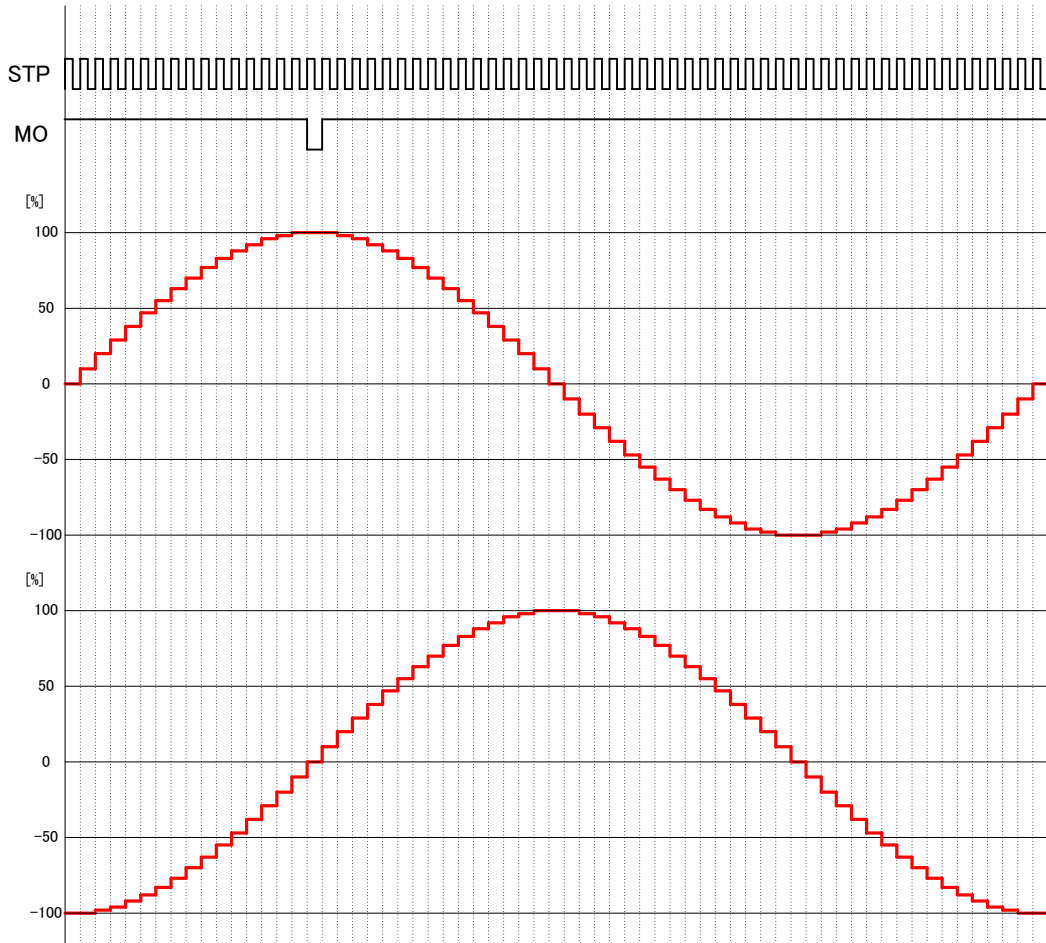


1/8 Step (CW)

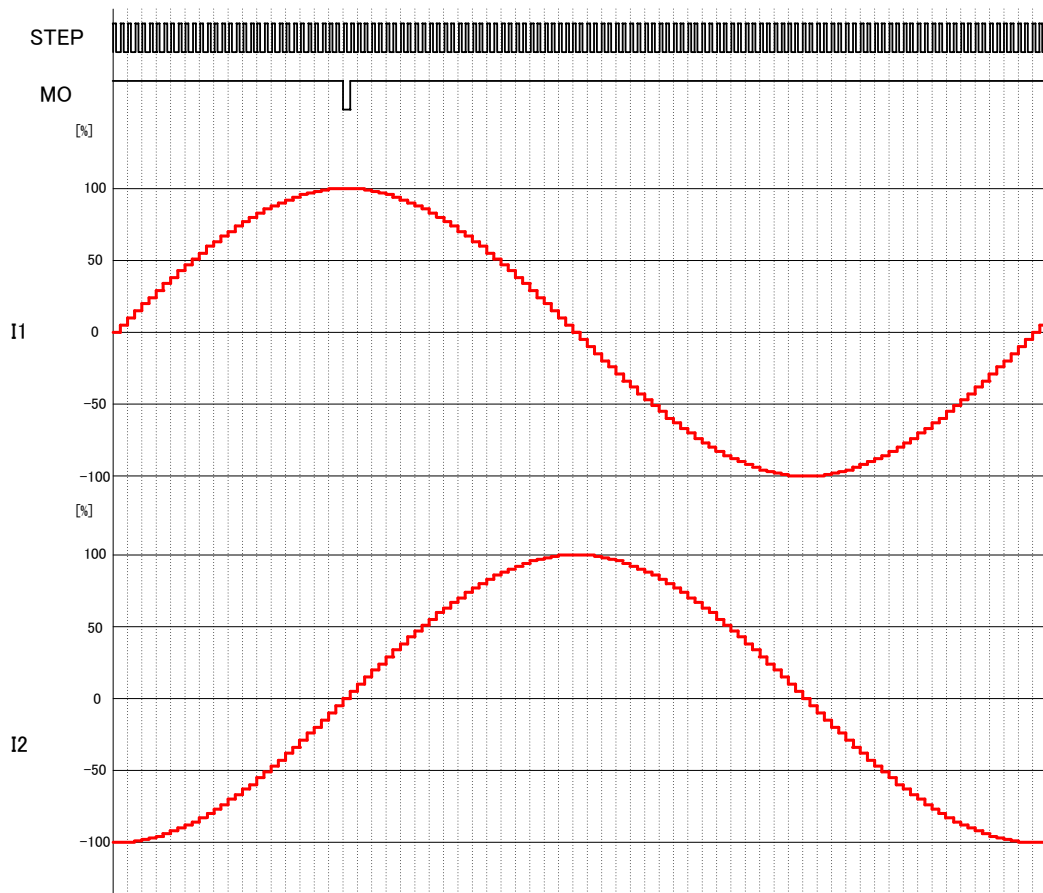


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1/16 Step Mode (CW)

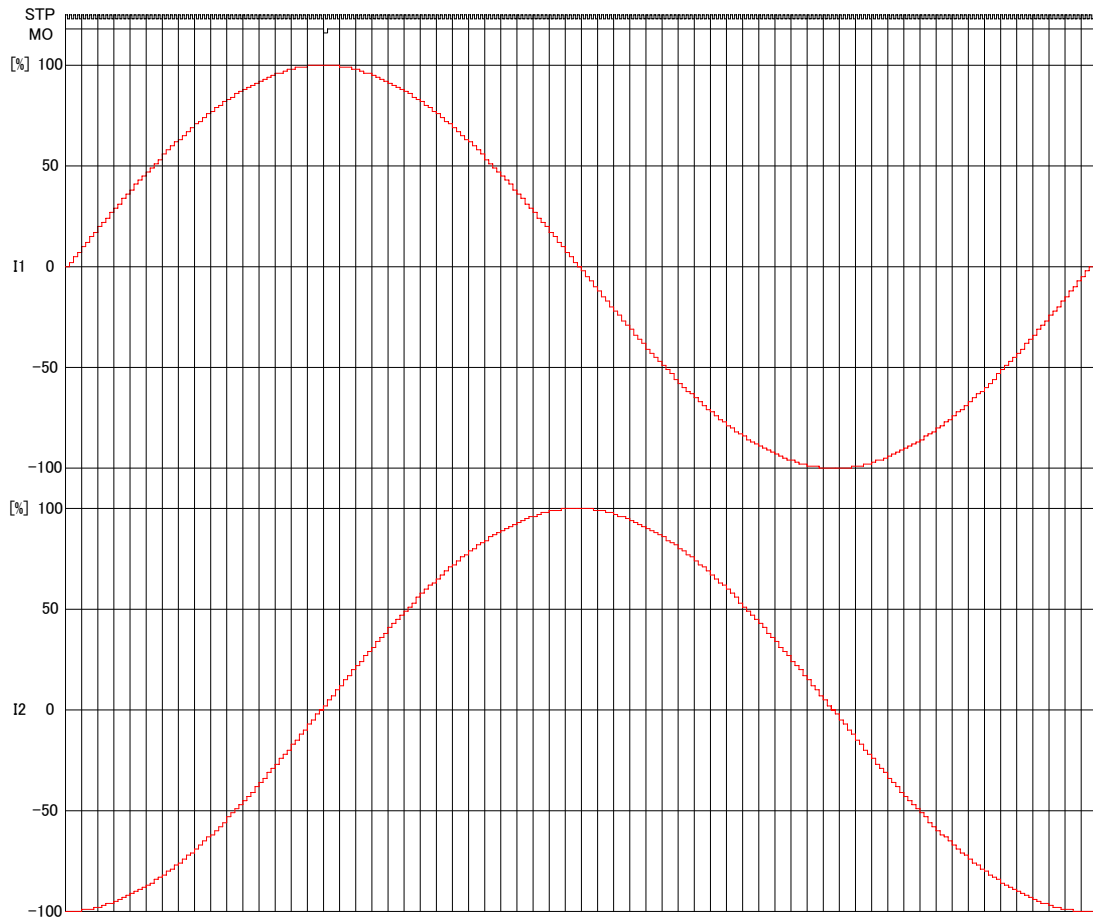


1/32 Step Mode (CW)

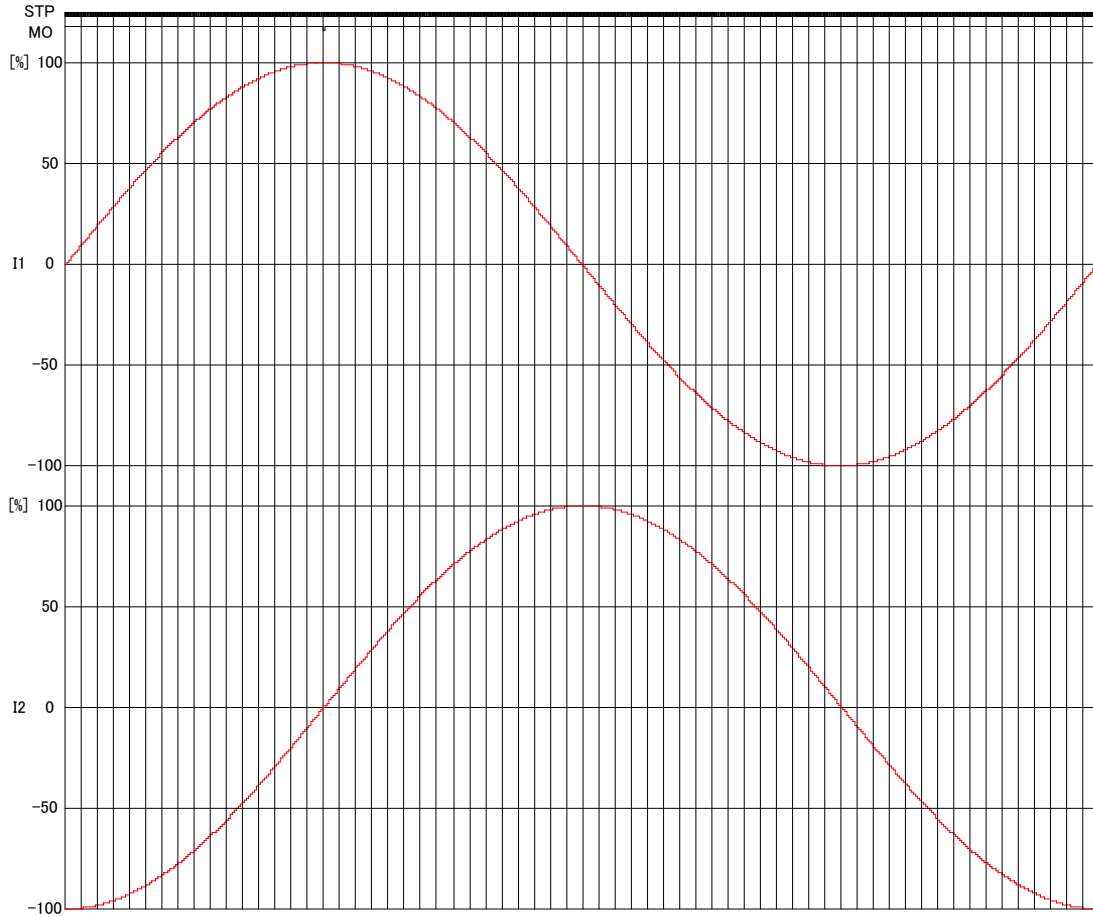


LV8729V Application Note

1/64 Step Mode (CW)

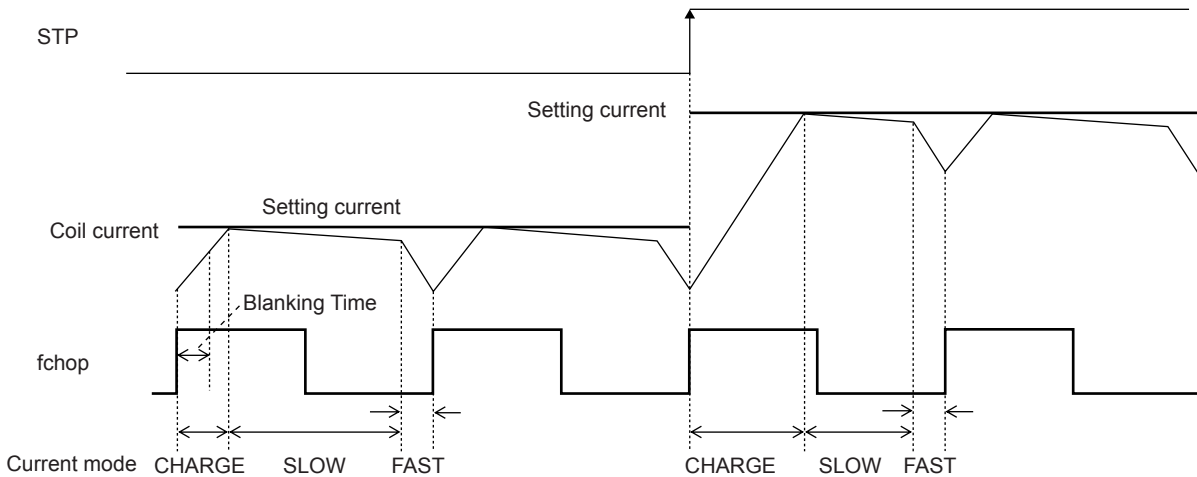


1/128 Step Mode (CW)



LV8729V Application Note

(15) Current control operation (Sine-wave increasing direction)



(Sine-wave decreasing direction)

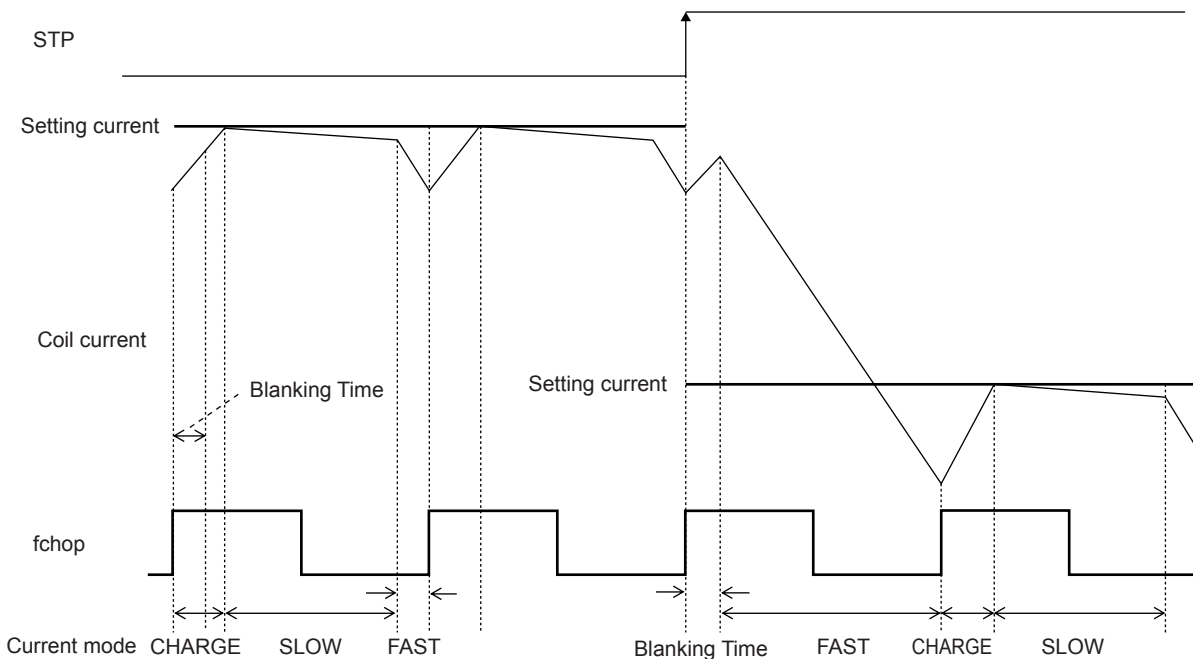


Figure 16. Constant current control timing chart

Each of current modes operates with the follow sequence.

- The IC enters CHARGE mode at a rising edge of the chopping oscillation. (A period of CHARGE mode (Blanking Time) is forcibly present in approximately $1\mu\text{s}$, regardless of the current value of the coil current (ICOIL) and set current (IREF)).
- In a period of Blanking Time, the coil current (ICOIL) and the setting current (IREF) are compared.
 - If an $\text{ICOIL} < \text{IREF}$ state exists during the charge period:
 - The IC operates in CHARGE mode until $\text{ICOIL} \geq \text{IREF}$. After that, it switches to SLOW DECAY mode and then switches to FAST DECAY mode in the last approximately $1\mu\text{s}$ of the period.
 - If no $\text{ICOIL} < \text{IREF}$ state exists during the charge period:
 - The IC switches to FAST DECAY mode and the coil current is attenuated with the FAST DECAY operation until the end of a chopping period.

The above operation is repeated. Normally, in the sine wave increasing direction the IC operates in SLOW (+ FAST) DECAY mode, and in the sine wave decreasing direction the IC operates in FAST DECAY mode until the current is attenuated and reaches the set value and the IC operates in SLOW (+ FAST) DECAY mode.

LV8729V Application Note

(16) Output transistor operation mode

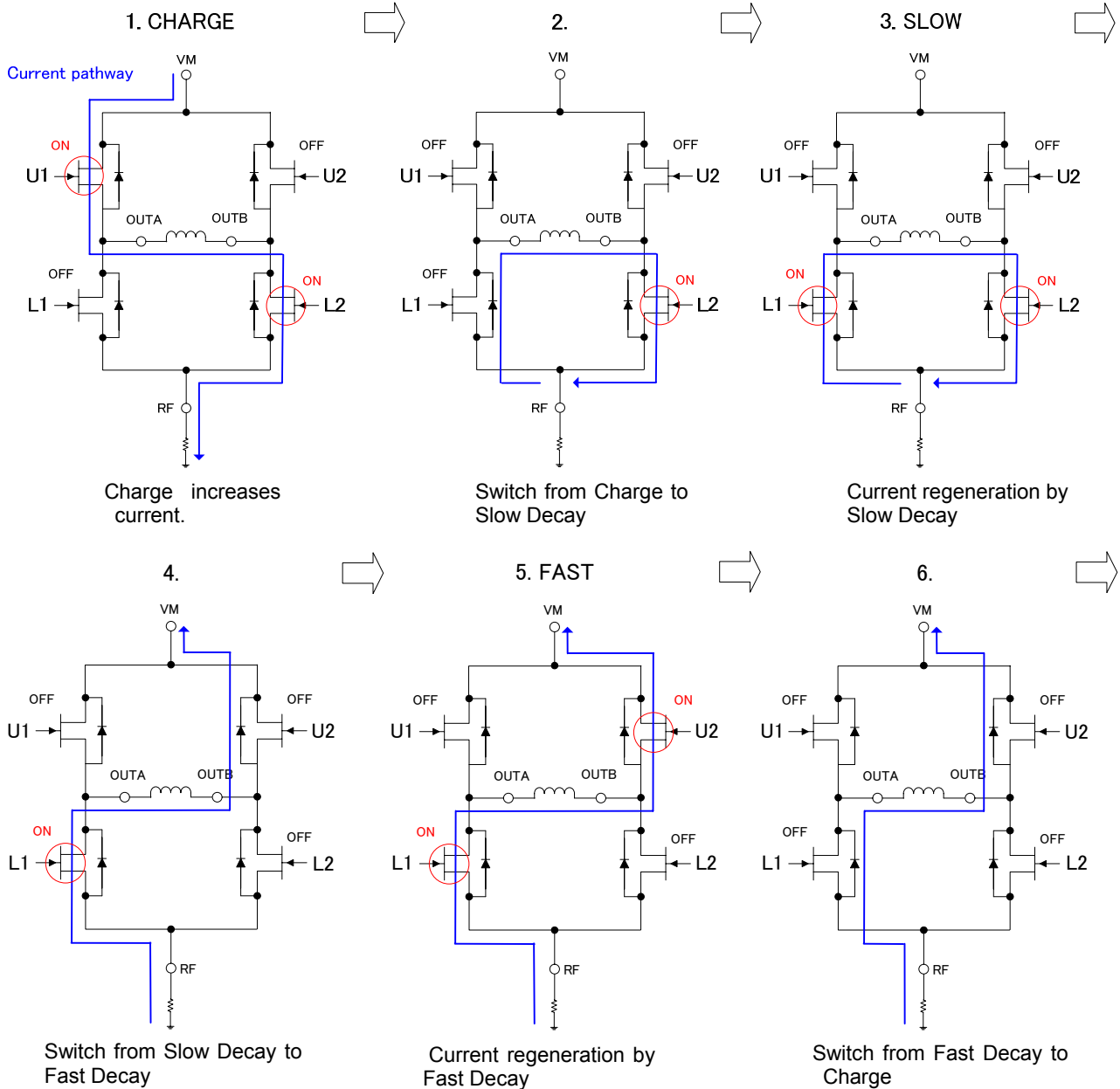


Figure 17. Output transistor operation sequence

This IC controls constant current by performing chopping to output transistor.

As shown above, by repeating the process from 1 to 6, setting current is maintained.

Chopping consists of 3 modes: Charge/ Slow decay/ Fast decay. In this IC, for switching mode (No.2, 4, 6), there are "off period" in upper and lower transistor to prevent crossover current between the transistors. This off period is set to be constant ($\approx 0.375\mu\text{s}$) which is controlled by the internal logic. The diagrams show parasitic diode generated due to structure of MOS transistor. When the transistor is off, output current is regenerated through this parasitic diode.

Output Transistor Operation Function

OUTA→OUTB (CHARGE)

Output Tr	CHARGE	SLOW	FAST
U1	ON	OFF	OFF
U2	OFF	OFF	ON
L1	OFF	ON	ON
L2	ON	ON	OFF

OUTB→OUTA (CHARGE)

Output Tr	CHARGE	SLOW	FAST
U1	OFF	OFF	ON
U2	ON	OFF	OFF
L1	ON	ON	OFF
L2	OFF	ON	ON

LV8729V Application Note

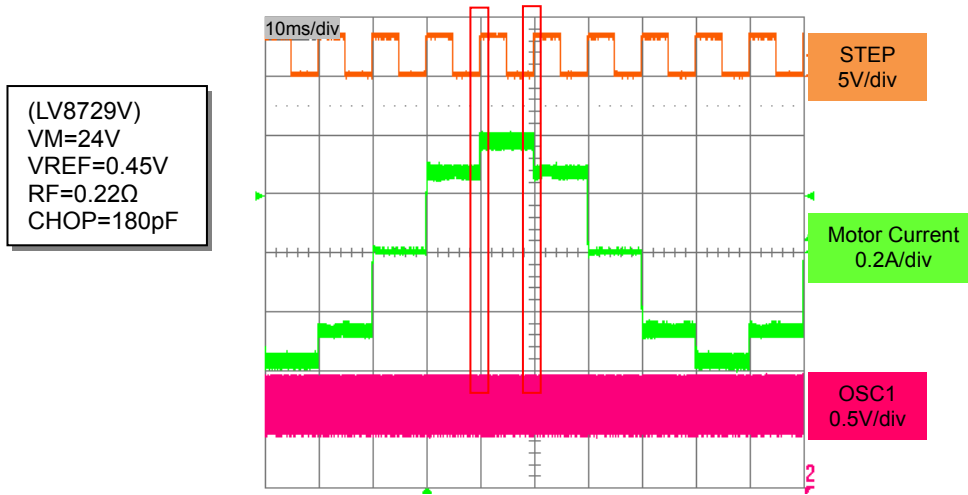


Figure 18. Constant current control waveform

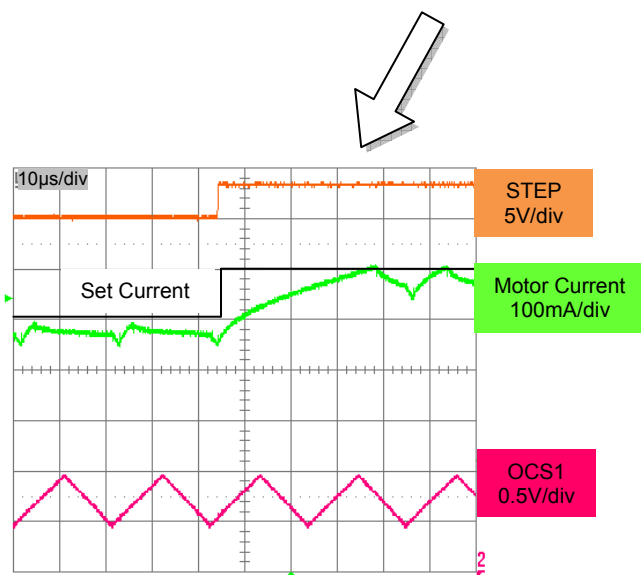


Figure 19. Sine wave increasing direction

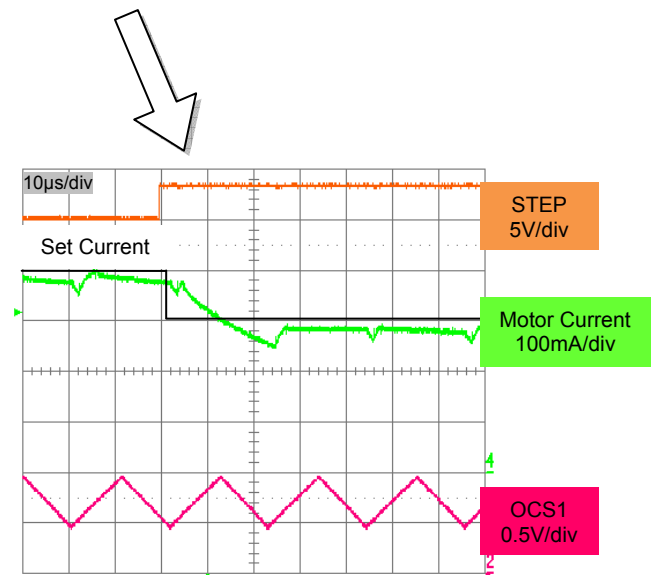
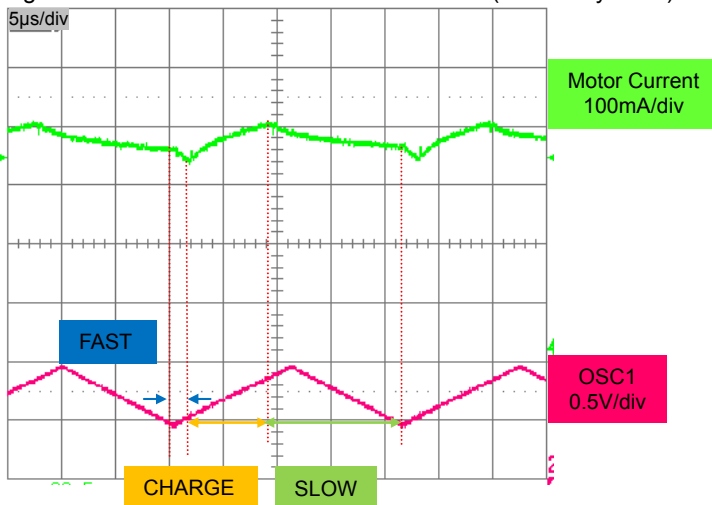


Figure 20. Sine wave decreasing direction

Figure 21. Constant current control waveform (Stationary state)



Motor current switches to Fast Decay mode when triangle wave (CHOP) switches from Discharge to Charge. Approximately after 1μs, the motor current switches to Charge mode. When the current reaches to the setting current, it is switched to Slow Decay mode which continues over the Discharge period of triangle wave.

(17) Blanking period

If, when exercising PWM constant-current chopping control over the motor current, the mode is switched from decay to charge, the recovery current of the parasitic diode may flow to the current sensing resistance, causing noise to be carried on the current sensing resistance pin, and this may result in erroneous detection. To prevent this erroneous detection, a blanking period is provided to prevent the noise occurring during mode switching from being received. During this period, the mode is not switched from charge to decay even if noise is carried on the current sensing resistance pin. It is approximately 1 μ s in the blanking time for this IC.

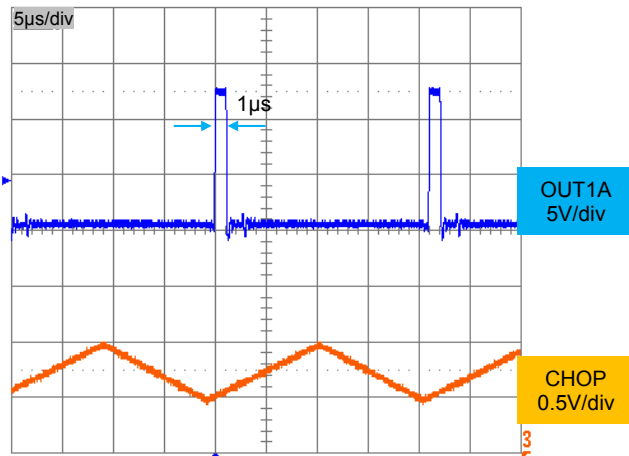


Figure 22. Blanking time waveform

(18) Micro step mode switching operation

When Micro step mode is switched while the motor is rotating, each drive mode operates with the following sequence.

If you switch Microstepping mode while the motor is driving, the mode setting will be reflected from the next STEP and the motor advances to the position shown in the following.

1. Microstepping (1/128-, 1/64-, 1/32-, 1/16-, 1/8-, Quarter-, Half-step)

→ Microstepping (1/128-, 1/64-, 1/32-, 1/16-, 1/8-, Quarter-, Half-step)

When a microstepping switches to the next microstepping, the excitation position is switched to the next corresponding step angle of the next microstepping mode.

e.g.) When the rotation direction is forward at 1/8-step, and if you switch to 1/128-step ($\theta_{16} - \theta_{47}$), the step angle is set to θ_{48} at the next step.

When the rotation direction is forward at 1/128 step. If you switch to 1/8-step (θ_{48}), the step angle is set to θ_{49} at the next step.

2. Microstepping (1/128-, 1/64-, 1/32-, 1/16-, 1/8-, Quarter-, Half-step) → Full-step

When a microstepping switches to the full-step, the excitation position is switched to full-step angle of the present quadrant. Caution is required when switching from θ_{64} or higher step angle of microstepping position to full-step.

e.g.) When the rotation direction is forward at 1/16 step ($\theta_0 - \theta_{124}$) and if you switch to full-step, the step angle is set to θ_{64} at the next step.

When the rotation direction is forward at 1/16 step (θ_{128}) and if you switch to full-step, the step angle is set to $-\theta_{64}$ at the next step.

3. Full-step → Micro step (1/128-, 1/64-, 1/32-, 1/16-, 1/8-, Quarter-, Half-step)

When full step switches to microstepping, the excitation position is switched to the next corresponding step angle.

e.g.) When the rotation direction is forward at Full step (θ_{64}) and if you switch to Quarter-step, the step angle is set to θ_{96} at the next step.

(Please refer to the step angle on p.13-15 for the description on “ θ^* ”.)

LV8729V Application Note

Micro step mode switching operation

- Micro step → Micro step
 VM=24V, VDD=5V
 VREF=1.1V, RNF=0.22Ω
 PS=High, OE=High, RST=High, fSTEP=400Hz

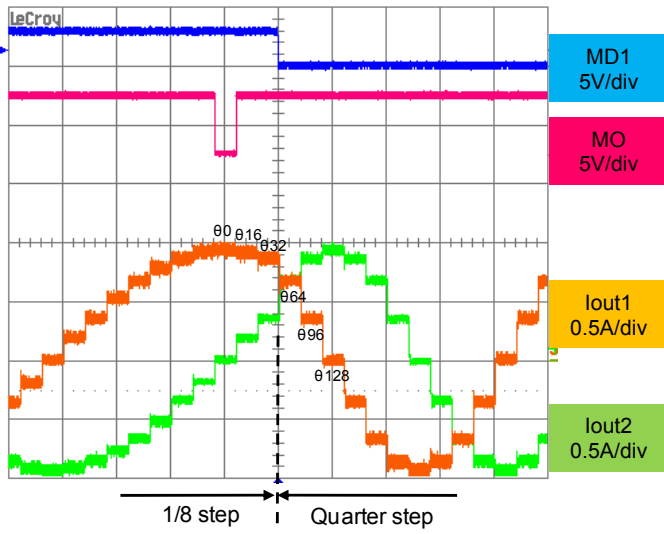


Figure.23 Micro step(1/8step) → Micro step(quarter step)
 MD2=High , MD3=Low

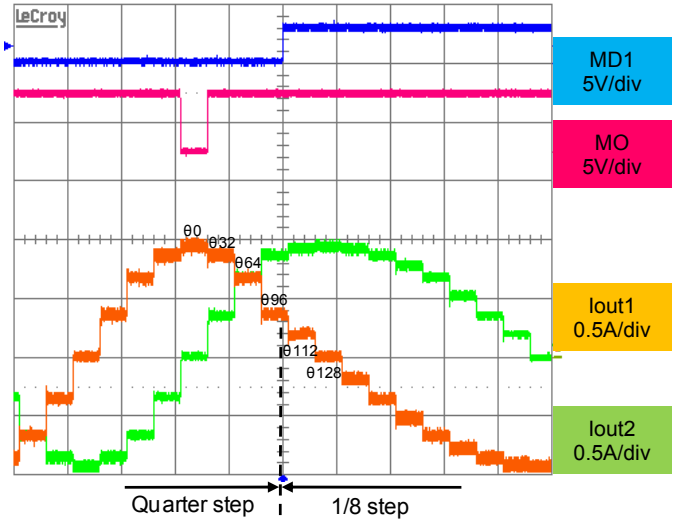


Figure24. Micro step(quarter step) → Micro step(1/8step)
 MD2=High , MD3=Low

- Micro step → Full step, Full step → Micro step
 VM=24V, VDD=5V
 VREF=1.1V, RNF=0.22Ω
 PS=High, OE=High, RST=High, fSTEP=200Hz

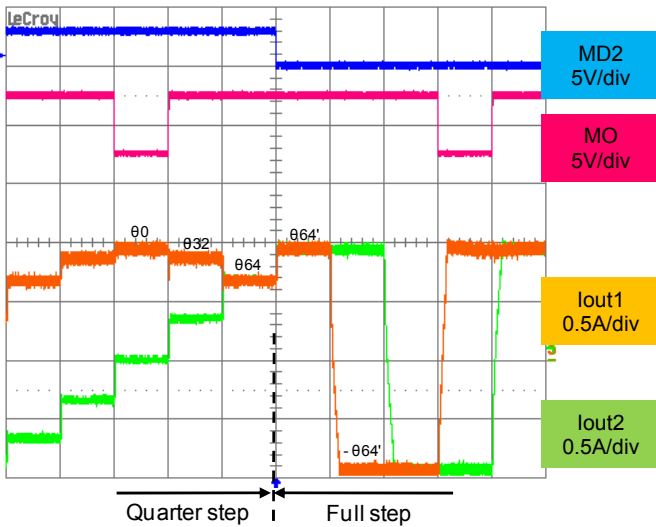


Figure.25 Micro step(quarter step) → Full step
 MD1=Low , MD3=Low

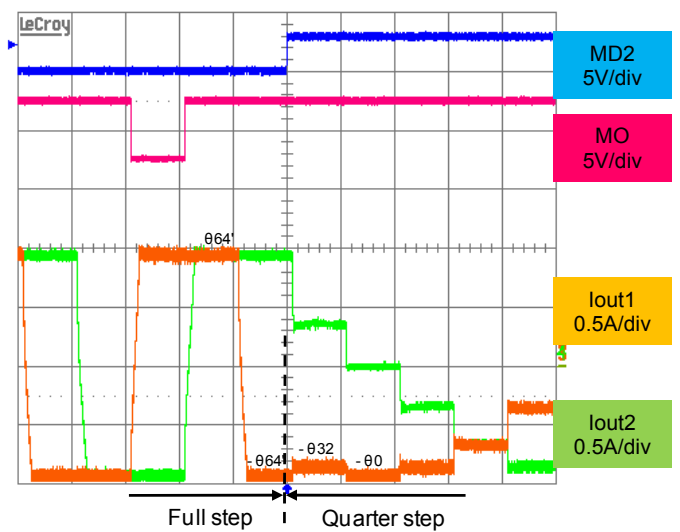
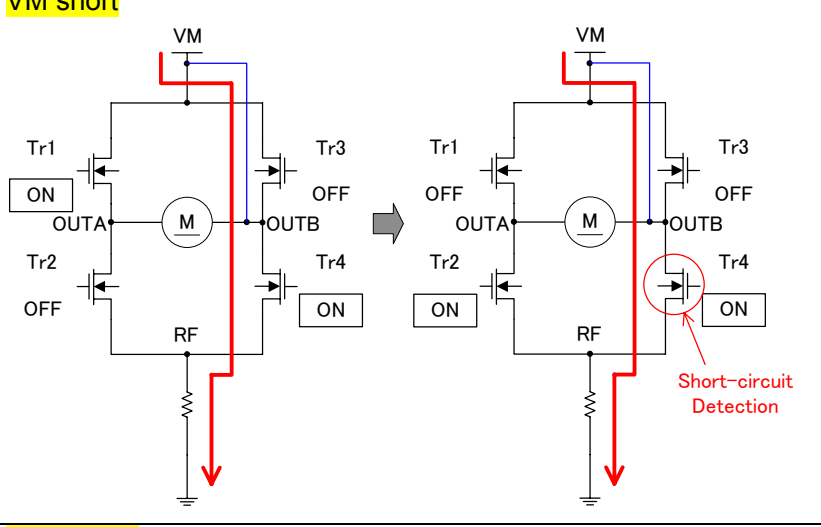
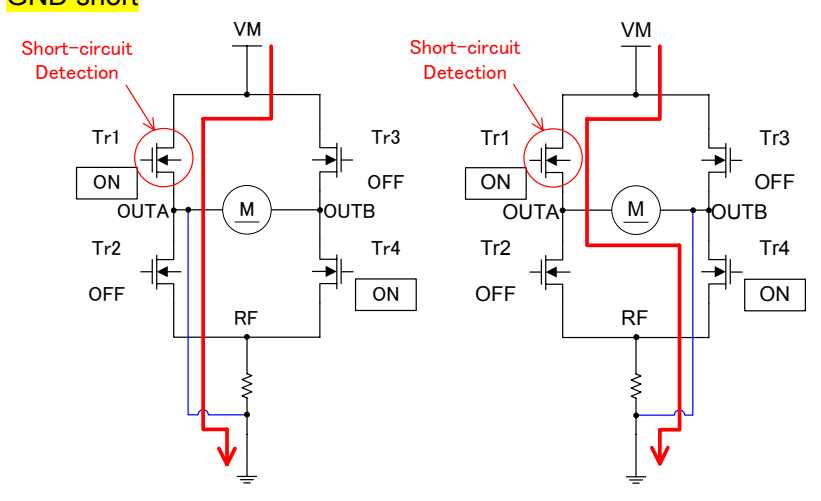
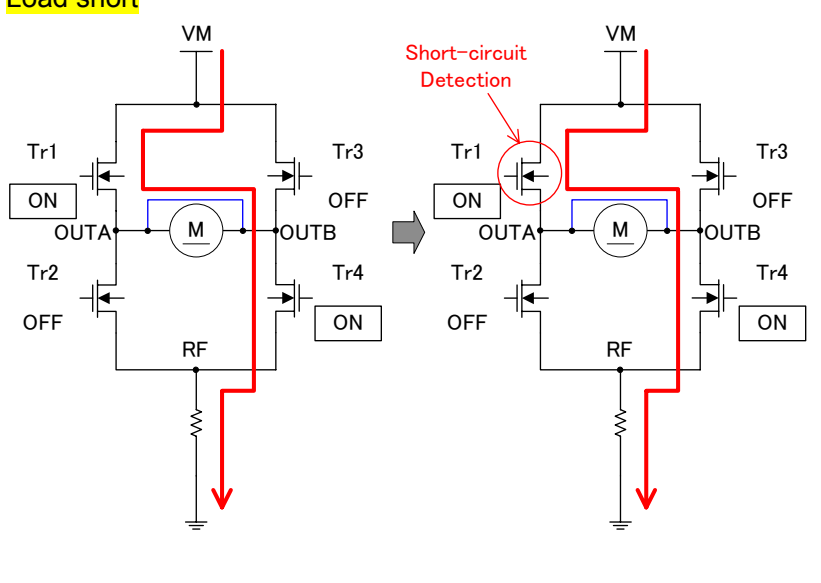


Figure26. Full step → Micro step (quarter step)
 MD1=Low , MD3=Low

LV8729V Application Note

Output short-circuit protection function

(1) Output short-circuit detection operation

<p>VM short</p> 	<ol style="list-style-type: none"> 1.High current flows if Tr3 and Tr4 are ON. 2.If RF voltage > setting voltage, then the mode switches to SLOW decay. 3.If the voltage between D and S of Tr4 exceeds the reference voltage for 2μs, short status is detected.
<p>GND short</p> 	<p>(left schematic)</p> <ol style="list-style-type: none"> 1.High current flows if Tr3 and Tr4 are ON 2. If the voltage between D and S of Tr1 exceeds the reference voltage for 2μs, short status is detected. <p>(right schematic)</p> <ol style="list-style-type: none"> 1.Without going through RF resistor, current control does not operate and current will continue to increase in CHARGE mode. 2. If the voltage between D and S of Tr1 exceeds the reference voltage for 2μs, short status is detected.
<p>Load short</p> 	<ol style="list-style-type: none"> 1. Without L load, high current flows. 2. If RF voltage > setting voltage, then the mode switches to SLOW decay. 3. During load short state in SLOW decay mode, current does not flow and over current state is not detected. Then the mode is switched to FAST decay according to chopping cycle. 4. Since FAST state is short ($\approx 1\mu$s), switches to CHARGE mode before short is detected. 5. If voltage between D and S exceeds the reference voltage continuously during blanking time at the start of CHARGE mode (Tr1), CHARGE state is fixed (even if RF voltage exceeds the setting voltage, the mode is not switched to SLOW decay). After 2μs or so, short is detected.

LV8729V Application Note

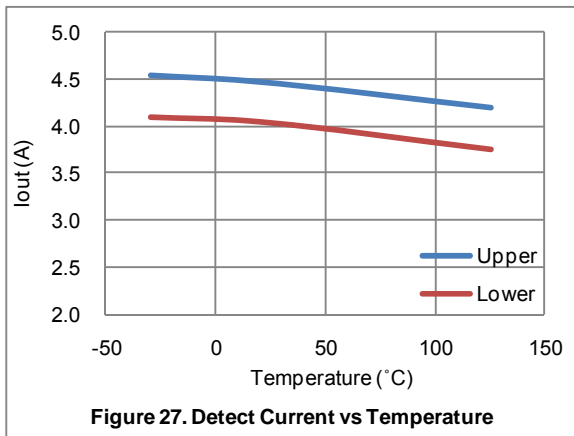
(2) Output short-circuit protection detect current (Reference value)

Short protector operates when abnormal current flows into the output transistor.

Ta = 25°C (typ)

Upper-side Transistor	4.46A
Lower-side Transistor	4.04A

*RF=GND



(3) Timer latch period

Built-in output short-circuit protection circuit makes output to enter in stand-by mode. This function prevents the IC from damaging when the output shorts circuit by a voltage short or a ground short, etc. When output short state is detected for 2μs, short-circuit detection circuit state the operating and output is once turned OFF. Subsequently, the output is turned ON again after the timer latch period (typ. 256μs). If the output remains in the short-circuit state, turn OFF the output, fix the output to the wait mode, and turn ON the EMO output. When output is fixed in stand-by mode by output short protection circuit, output is released the latch by setting ST = "L".

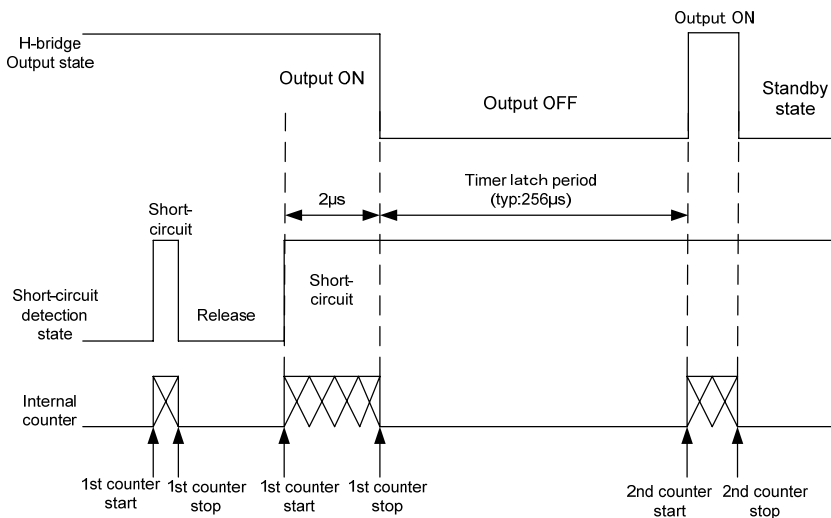


Figure 28 . short-circuit protection function timing chart

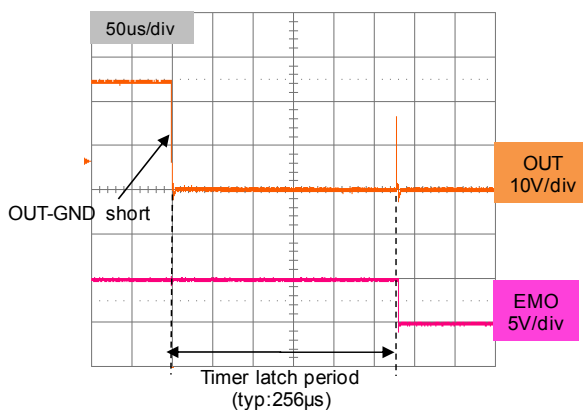


Figure 29. Timer latch period waveform

LV8729V Application Note

(4) Unusual condition warning output pins (EMO)

The LV8729V is provided with the EMO pin which notifies the CPU of an unusual condition if the protection circuit operates by detecting an unusual condition of the IC. This pin is of the open-drain output type and when an unusual condition is detected, the EMO output is placed in the ON (EMO = Low) state.

Furthermore, the EMO pin is placed in the ON state when one of the following conditions occurs.

1. Shorting-to-power, shorting-to-ground, or shorting-to-load occurs at the output pin and the output short-circuit protection circuit is activated.
2. The IC junction temperature rises and the thermal protection circuit is activated.

Thermal shutdown function

The thermal shutdown circuit is incorporated and the output is turned off when junction temperature T_j exceeds 180°C and the abnormal state warning output is turned on. As the temperature falls by hysteresis, the output turned on again (automatic restoration).

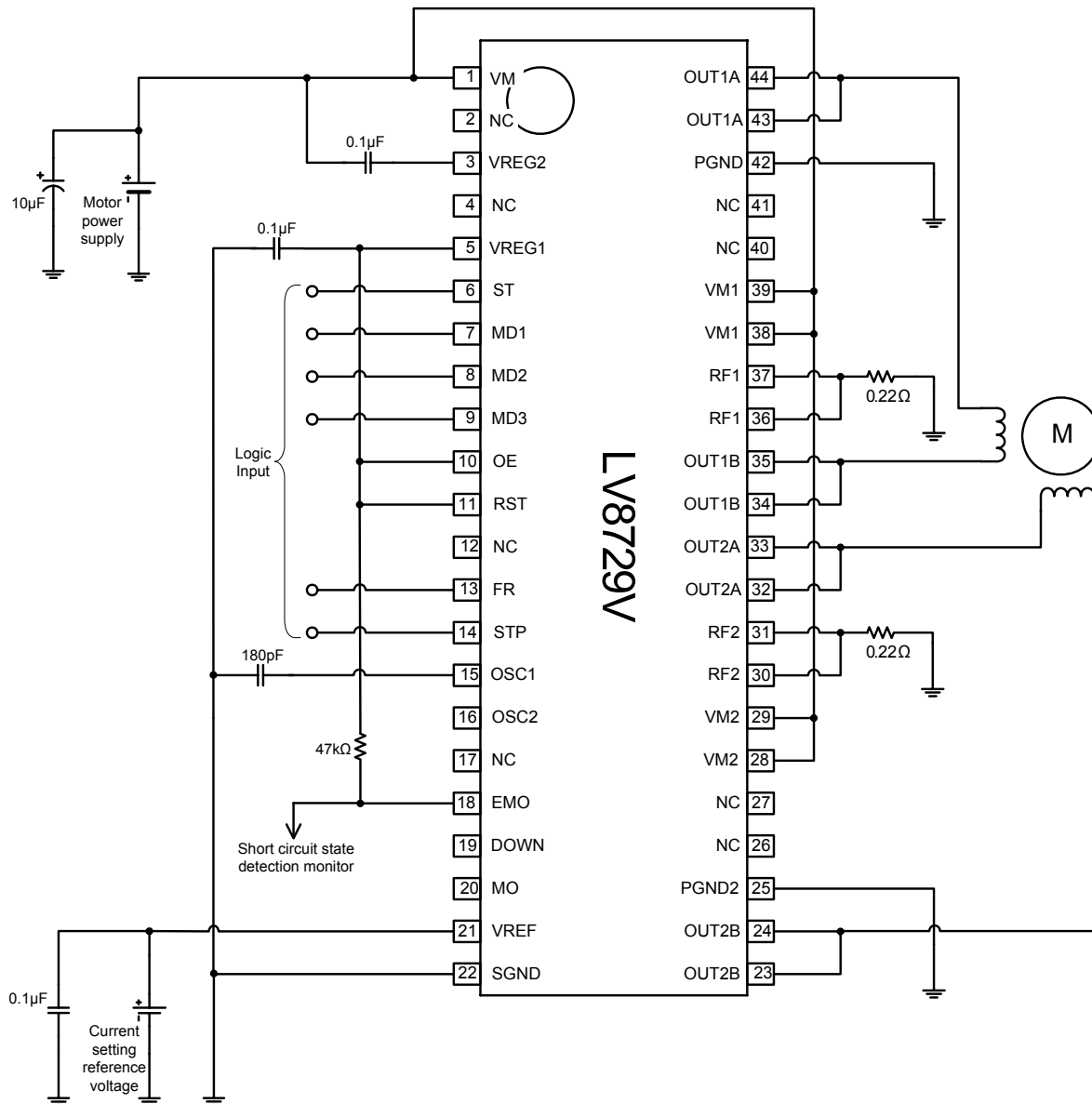
The thermal shutdown circuit does not guarantee the protection of the final product because it operates when the temperature exceed the junction temperature of $T_{j\text{max}}=150^{\circ}\text{C}$.

$T_{SD} = 180^{\circ}\text{C}$ (typ)

$\Delta T_{SD} = 40^{\circ}\text{C}$ (typ)

LV8729V Application Note

Application Circuit Example



The above sample application circuit is set to the following conditions:

- Output enable function fixed to the output state (OE = "H")
- Reset function fixed to the output state (RST = "H")
- Chopping frequency : 55.5kHz (Cosc1 = 180pF)

The set current value is as follows:

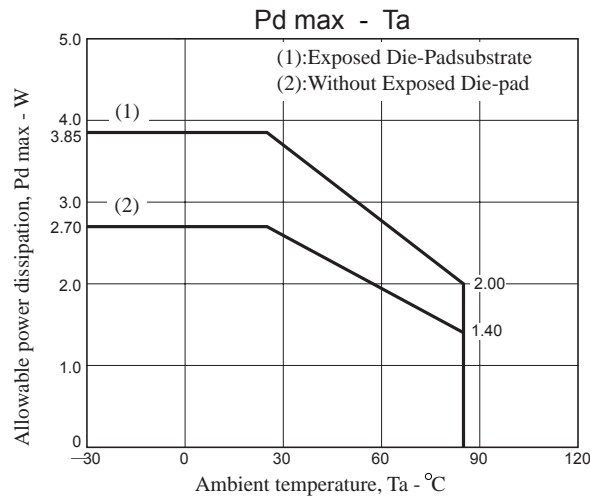
$$I_{OUT} = (\text{Current setting reference voltage} / 5) / 0.22\Omega$$

LV8729V Application Note

Allowable power dissipation

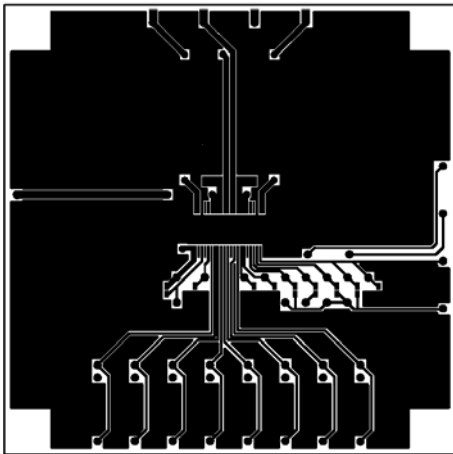
The pad on the backside of the IC functions as heatsink by soldering with the board. Since the heat-sink characteristics vary depends on board type, wiring and soldering, please perform evaluation with your board for confirmation.

Specified circuit board: 90mm x 90mm x 1.6mm, glass epoxy 2-layer board

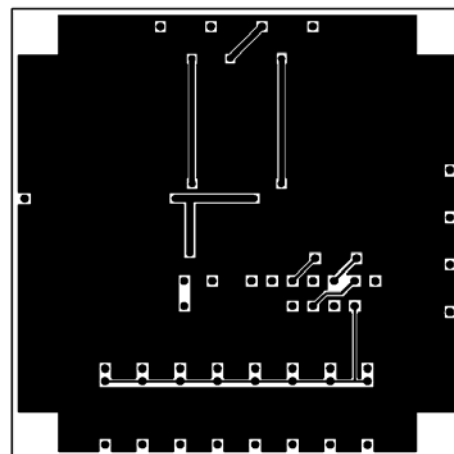


Substrate Specifications (Substrate recommended for operation of LV8729V)

Size	: 90mm × 90mm × 1.6mm (two-layer substrate [2S0P])
Material	: Glass epoxy
Copper wiring density	: L1 = 85% / L2 = 90%



L1 : Copper wiring pattern diagram



L2 : Copper wiring pattern diagram

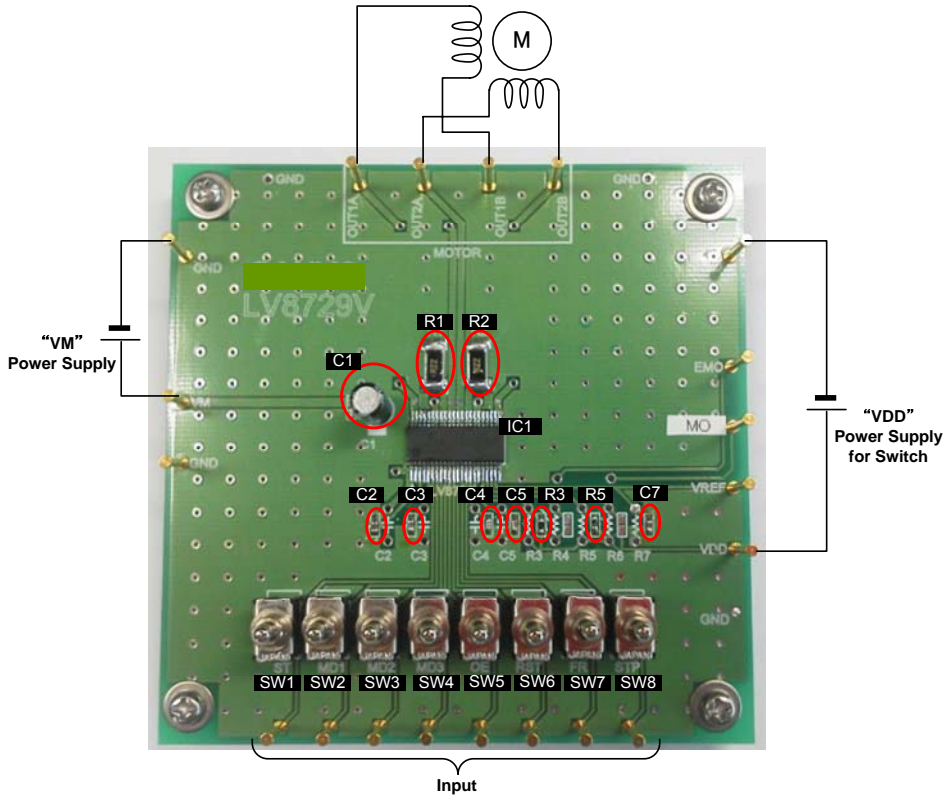
Cautions

- 1) The data for the case with the Exposed Die-Pad substrate mounted shows the values when 90% or more of the Exposed Die-Pad is wet.
- 2) For the set design, employ the derating design with sufficient margin.
Stresses to be derated include the voltage, current, junction temperature, power loss, and mechanical stresses such as vibration, impact, and tension.
Accordingly, the design must ensure these stresses to be as low or small as possible.
The guideline for ordinary derating is shown below:
 - (1)Maximum value 80% or less for the voltage rating
 - (2)Maximum value 80% or less for the current rating
 - (3)Maximum value 80% or less for the temperature rating
- 3) After the set design, be sure to verify the design with the actual product.
Confirm the solder joint state and verify also the reliability of solder joint for the Exposed Die-Pad, etc.
Any void or deterioration, if observed in the solder joint of these parts, causes deteriorated thermal conduction, possibly resulting in thermal destruction of IC.

LV8729V Application Note

Evaluation board

LV8729V (90mm x 90mm x 1.6mm, glass epoxy 2-layer board, with backside mounting)

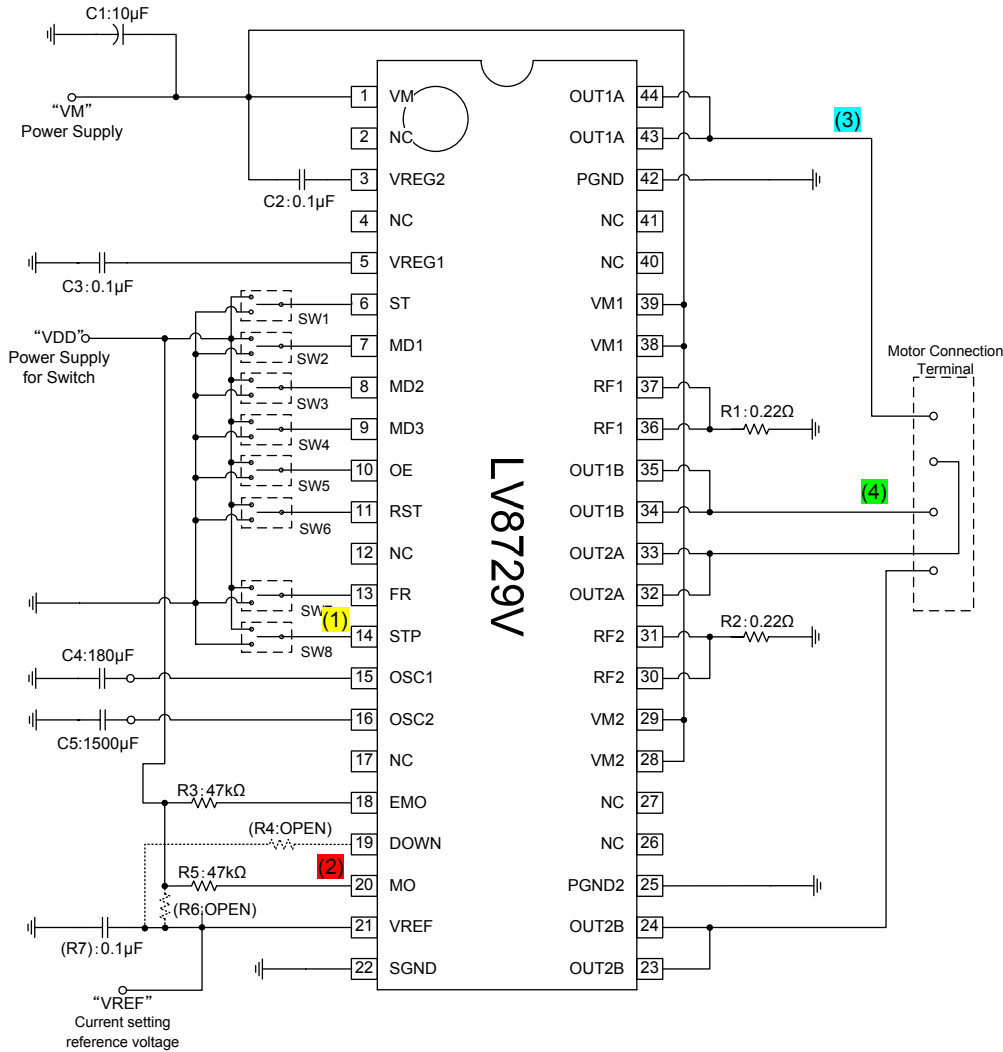


Bill of Materials for LV8729V Evaluation Board

Designator	Qty	Description	Value	Tol	Footprint	Manufacturer	Manufacturer Part Number	Substitution Allowed	Lead Free
C1	1	VM Bypass capacitor	10 μ F 50V	\pm 20%		SUN Electronic Industries	50ME10HC	yes	yes
C2	1	VREG2 stabilization Capacitor	0.1 μ F 100V	\pm 10%		murata	GRM188R72A104KA35D	yes	yes
C3	1	VREG1 stabilization Capacitor	0.1 μ F 100V	\pm 10%		murata	GRM188R72A104KA35D	yes	yes
C4	1	Capacitor to set chopping frequency	180pF 50V	\pm 5%		murata	GRM1882C1H181JA01	yes	yes
C5	1	Capacitor to set switching holding current	1500pF 50V	\pm 5%		KOA	GRM1882C1H152J	yes	yes
R1	1	Channel 1 Output current detective Resistor	0.22 Ω 1W	\pm 5%		ROHM	MCR100JZHJLR22	yes	yes
R2	1	Channel 2 Output current detective Resistor	0.22 Ω 1W	\pm 5%		ROHM	MCR100JZHJLR22	yes	yes
R3	1	Pull-up Resistor for terminal EMO	47k Ω 1/10W	\pm 5%		KOA	RK73B1JT473J	yes	yes
R5	1	Pull-up Resistor for terminal MO	47k Ω 1/10W	\pm 5%		KOA	RK73B1JT473J	yes	yes
R7	1	VREF stabilization Capacitor	0.1 μ F 100V	\pm 10%		murata	GRM188R72A104KA35D	yes	yes
IC1	1	Motor Driver			SSOP44K (275mil)	ON Semiconductor	LV8729V	No	yes
SW1-SW8	8	Switch				MIYAMA	MS-621-A01	yes	yes
TP1-TP20	20	Test points				MAC8	ST-1-3	yes	yes

LV8729V Application Note

Evaluation board circuit



Evaluation Board Manual

[Supply Voltage]

VM (9 to 32V): Power Supply for LSI

VREF (0 to 3V): Const. Current Control for Reference Voltage

VDD (2 to 5V): Logic "High" voltage for toggle switch

[Toggle Switch State]

Upper Side: High (VDD)

Middle: Open, enable to external logic input

Lower Side: Low (GND)

[Operation Guide]

- Initial Condition Setting:** Set "Open" the toggle switch STEP, and "Open or Low" the other switches
- Motor Connection:** Connect the Motors between OUT1A and OUT1B, between OUT2A and OUT2B.
- Power Supply:** Supply DC voltage to VM, VREF and VDD.
- Ready for Operation from Standby State:** Turn "High" the following toggle switches : ST , OE, and RST. Channel 1 and 2 are into Full-Step excitement initial position (100%, -100%).
- Motor Operation:** Input the clock signal into the terminal STEP.
- Other Setting** (See Application Note for detail)
 - MD1 , MD2 , MD3 : Micro step resolution.
 - FR: Motor rotation direction (CW / CCW) setting.
 - RST : Initial Mode.
 - OE: Output Enable.

[Setting for External Component Value]

- Constant Current (100%)

At VREF=1.5V

$$I_{out} = VREF [V] / 5 / RF [ohm]$$

$$= 1.5 [V] / 5 / 0.22 [ohm]$$

$$= 1.36 [A]$$

- Chopping Frequency

$$F_{cp} = 1 / (C_{osc1} / 10 \times 10^{-6}) (Hz)$$

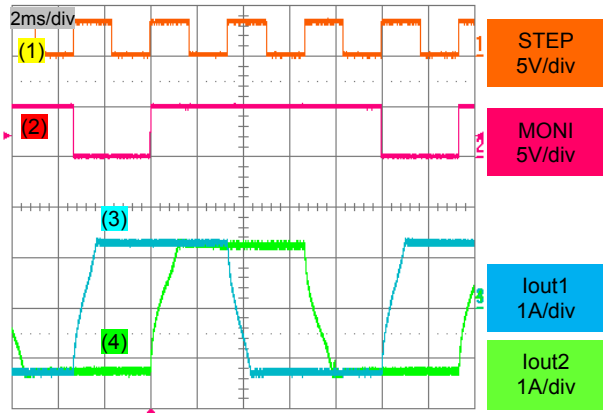
$$= 1 / (180 [pF] / 10 \times 10^{-6}) (Hz)$$

$$= 55.5 [kHz]$$

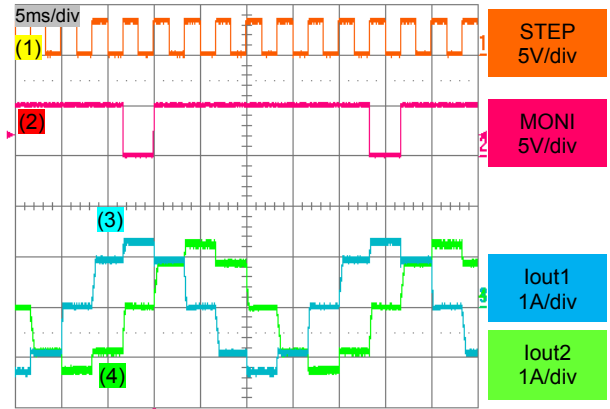
LV8729V Application Note

Waveform of LV8729V evaluation board.

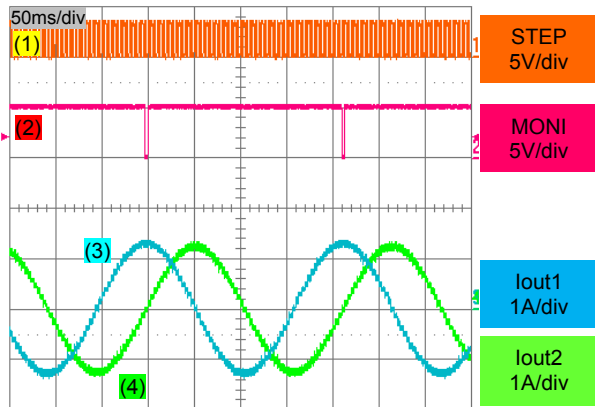
- Figure 30. Full Step
 VM=24V , VREF=1.5V , VDD=5V
 ST=H , OE=H , RST=H
 FR=L
 MD1=L , MD2=L , MD3=L
 STEP=300Hz (Duty 50%)



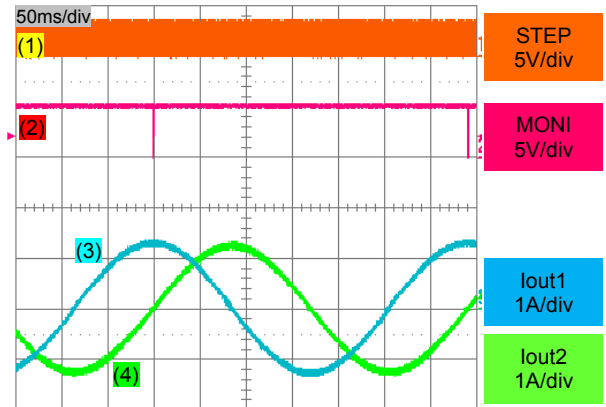
- Figure 31. Half Step
 VM=24V , VREF=1.5V , VDD=5V
 ST=H , OE=H , RST=H
 FR=L
 MD1=H , MD2=L , MD3=L
 STEP=300Hz (Duty 50%)



- Figure 32. 1/16 Step
 VM=24V , VREF=1.5V , VDD=5V
 ST=H , OE=H , RST=H
 FR=L
 MD1=L , MD2=L , MD3=H
 STEP=300Hz (Duty 50%)



- Figure 33. 1/128 Step
 VM=24V , VREF=1.5V , VDD=5V
 ST=H , OE=H , RST=H
 FR=L
 MD1=H , MD2=H , MD3=H
 STEP=1500Hz (Duty 50%)



LV8729V Application Note

Warning:

●Power supply connection terminal [VM, VM1, VM2]

- ✓ Make sure to short-circuit VM, VM1 and VM2. For controller supply voltage, the internal regulator voltage of VREG1 (typ 5V) is used.
- ✓ Make sure that supply voltage does not exceed the absolute MAX ratings under no circumstance. Noncompliance can be the cause of IC destruction and degradation.
- ✓ Caution is required for supply voltage because this IC performs switching.
- ✓ The bypass capacitor of the power supply should be close to the IC as much as possible to stabilize voltage. Also if you intend to use high current or back EMF is high, please augment enough capacitance.

●GND terminal [GND, PGND, Exposed Die-Pad]

- ✓ Since GND is the reference of the IC internal operation, make sure to connect to stable and the lowest possible potential. Since high current flows into PGND, connect it to one-point GND.
- ✓ The exposed die-pad is connected to the board frame of the IC. Therefore, do not connect it other than GND. Independent layout is preferable. If such layout is not feasible, please connect it to signal GND. Or if the area of GND and PGND is larger, you may connect the exposed die pad to the GND.
(The independent connection of exposed die pad to PGND is not recommended.)

●Internal power supply regulator terminal [VREG1]

- ✓ VREG1 is the power supply for logic (typ 5V).
- ✓ When VM supply is powered and ST is "H", VREG1 operates.
- ✓ Please connect capacitor for stabilize VREG1. The recommendation value is 0.1 μ F.
- ✓ Since the voltage of VREG1 fluctuates, do not use it as reference voltage that requires accuracy.

●Input terminal

- ✓ The logic input pin incorporates pull-down resistor (100k Ω).
- ✓ When you set input pin to low voltage, please short it to GND because the input pin is vulnerable to noise.
- ✓ The input is TTL level (H: 2V or higher, L: 0.8V or lower).
- ✓ VREF pin is high impedance.

●OUT terminal [OUT1A, OUT1B, OUT2A, OUT2B]

- ✓ During chopping operation, the output voltage becomes equivalent to VM voltage, which can be the cause of noise. Caution is required for the pattern layout of output pin.
- ✓ The layout should be low impedance because driving current of motor flows into the output pin.
- ✓ Output voltage may boost due to back EMF. Make sure that the voltage does not exceed the absolute MAX ratings under no circumstance. Noncompliance can be the cause of IC destruction and degradation.

●Current sense resistor connection terminal [RF1, RF2]

- ✓ To perform constant current control, please connect resistor to RF pin.
- ✓ To perform saturation drive (without constant current control), please connect RF pin to GND.
- ✓ If RF pin is open, then short protector circuit operates. Therefore, please connect it to resistor or GND.
- ✓ The motor current flows into RF – GND line. Therefore, please connect it to common GND line and low impedance line.

●NC terminal

- ✓ NC pin is not connected to the IC.
- ✓ If VM line and output line are wide enough in your layout, please use NC.

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